



US006840810B2

(12) **United States Patent**
Brunker et al.

(10) **Patent No.:** **US 6,840,810 B2**
(45) **Date of Patent:** **Jan. 11, 2005**

(54) **GROUPED ELEMENT TRANSMISSION CHANNEL LINK TERMINATION ASSEMBLIES**

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(*) Notice: Subject to any disclaimer, the term of this patent is extended or adjusted under 35 U.S.C. 154(b) by 0 days.

(21) Appl. No.: **10/331,712**

(22) Filed: **Dec. 30, 2002**

(65) **Prior Publication Data**

US 2003/0181104 A1 Sep. 25, 2003

Related U.S. Application Data

(60) Provisional application No. 60/354,581, filed on Feb. 5, 2002, and provisional application No. 60/344,223, filed on Dec. 28, 2001.

(51) **Int. Cl.**⁷ **H01R 23/07**

(52) **U.S. Cl.** **439/637**

(58) **Field of Search** 439/637, 577, 439/493, 660, 82, 931, 76.1, 620, 79, 78

(56) **References Cited**

U.S. PATENT DOCUMENTS

3,659,916 A	5/1972	Marcatilli	
3,918,120 A *	11/1975	Yoshikawa	16/108
4,188,715 A *	2/1980	Ammon et al.	29/884
4,382,236 A	5/1983	Suzuki	
4,707,671 A	11/1987	Suzuki et al.	
4,726,790 A *	2/1988	Hadjis	439/620
4,891,616 A	1/1990	Renken et al.	
5,015,519 A	5/1991	Yumoto	
5,069,626 A	12/1991	Patterson et al.	
5,114,364 A	5/1992	Hunter	

(List continued on next page.)

FOREIGN PATENT DOCUMENTS

DE	195 036 66	9/1995
GB	655803	8/1951
GB	2217114	10/1989
JP	1106602	4/1989
JP	62264081	4/1998
JP	10276203	9/1998
WO	WO 01/76015 A1	10/2001

OTHER PUBLICATIONS

U.S. patent application Ser. No. 10/330,910, Brunker et al., pending.

International search report in Copending PCT Application PCT/US02/41793, Mailed May 6, 2003.

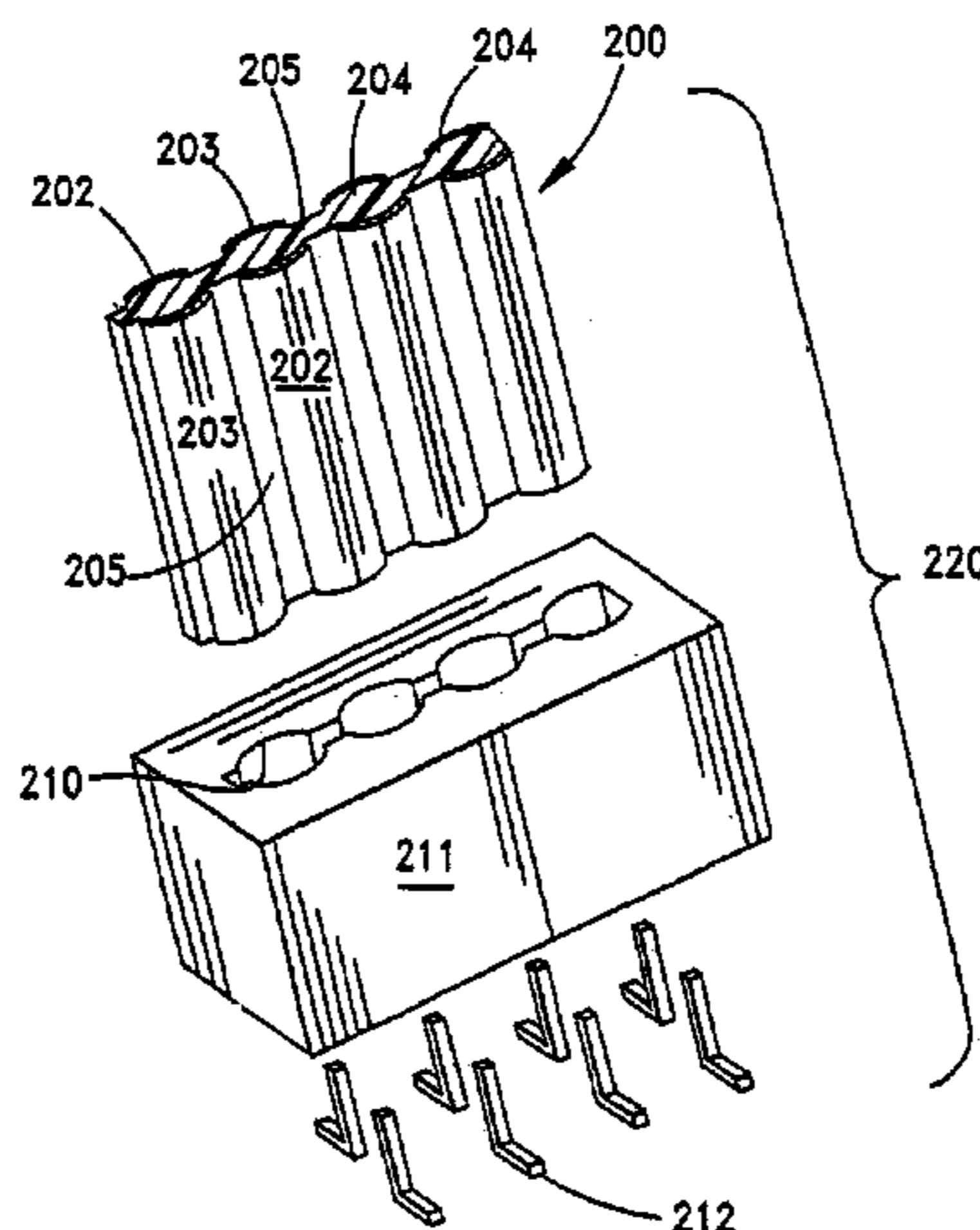
Numerical and Experimental Modeling of High-Speed Cables and Interconnects, Beker, Benjamin and Hirsch, Tom, 1997 Electronic Components and Technology.

Primary Examiner—Ross Gushi
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(74) *Attorney, Agent, or Firm*—Thomas D. Paulius

(57) **ABSTRACT**

Termination assemblies for terminating high-frequency data signal transmission lines include housings with one or more cavities that receive ends of the transmission line therein. The transmission line typically includes a dielectric body and a plurality of conductive elements disposed thereon, with the plurality of conductive elements being arranged in pairs for differential signal transmission. The termination assemblies, in one embodiment include hollow end caps that are formed from a dielectric and which have one or more conductive contacts or plated surfaces disposed on or within the cavity so that they will frictionally mate with the conductive traces on the transmission line. In another embodiment, a connector housing is provided with a center slot and a plurality of dual loop contacts to provide redundant circuit paths and low inductance to the termination assembly. A coupling element may be utilized in the slot to achieve a desired level of coupling between the termination contacts.

17 Claims, 18 Drawing Sheets



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U.S. PATENT DOCUMENTS			
5,133,669	A *	7/1992	Barnhouse et al. 439/78
5,149,915	A	9/1992	Brunker et al.
5,192,228	A	3/1993	Collins et al.
5,599,208	A *	2/1997	Ward 439/620
5,626,483	A	5/1997	Naitoh
6,102,744	A *	8/2000	Korsunsky et al. 439/637
6,185,354	B1 *	2/2001	Kronz et al. 385/129
6,200,146	B1 *	3/2001	Sarkissian 439/79
2003/0179050	A1	9/2003	Brunker et al.
* cited by examiner			

FIG. 1

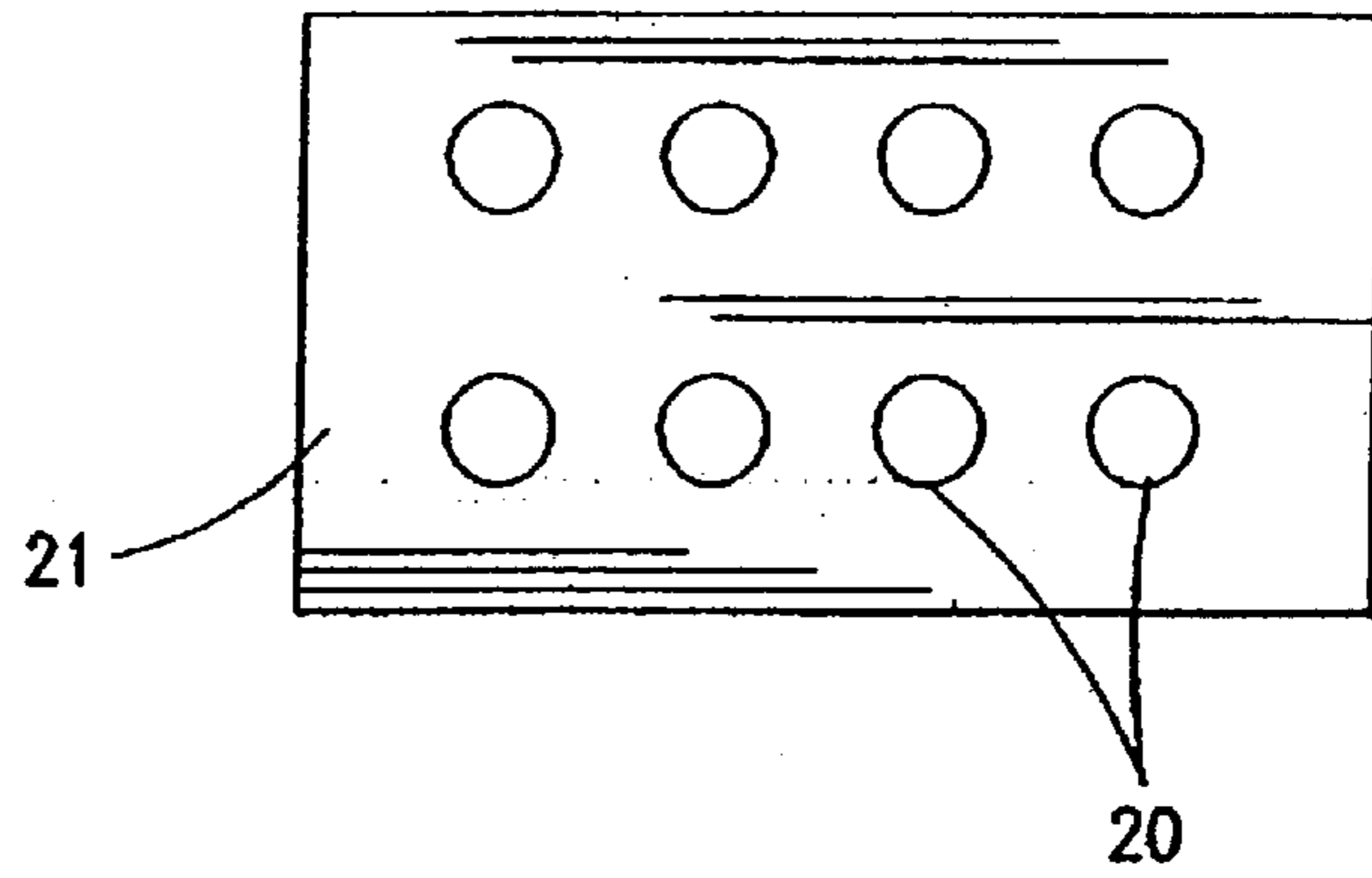


FIG. 2

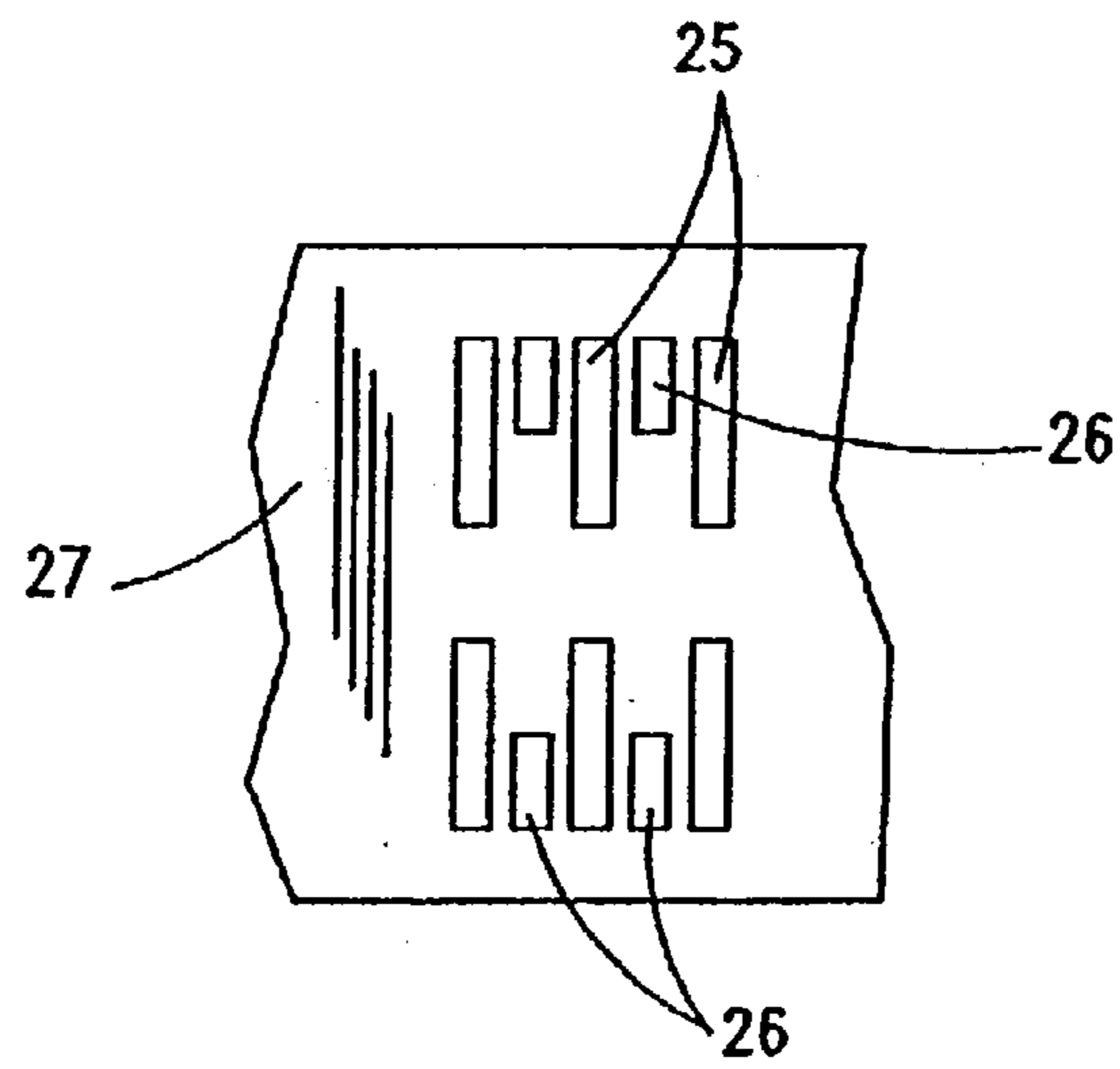


FIG. 3

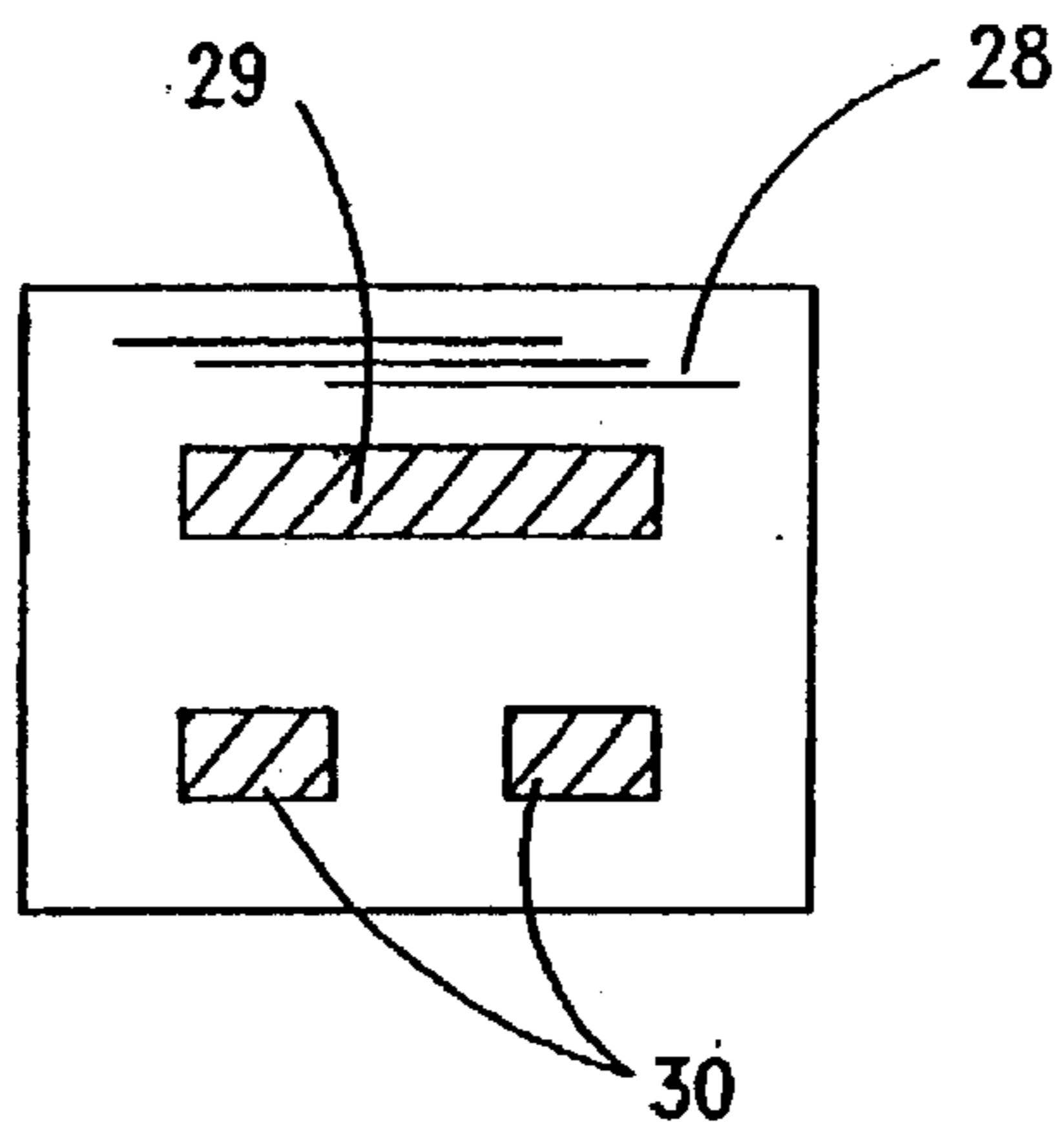


FIG. 4

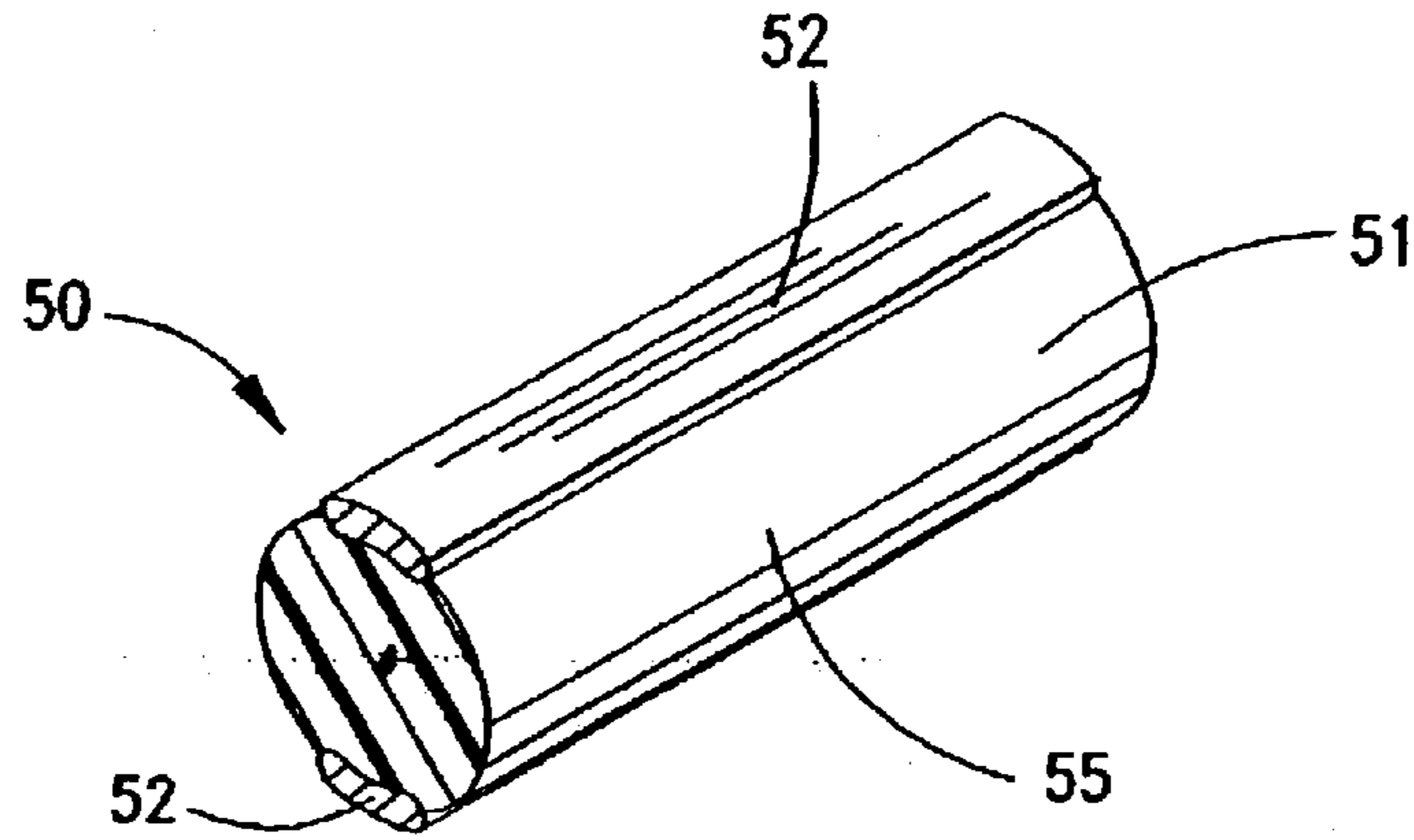


FIG. 5

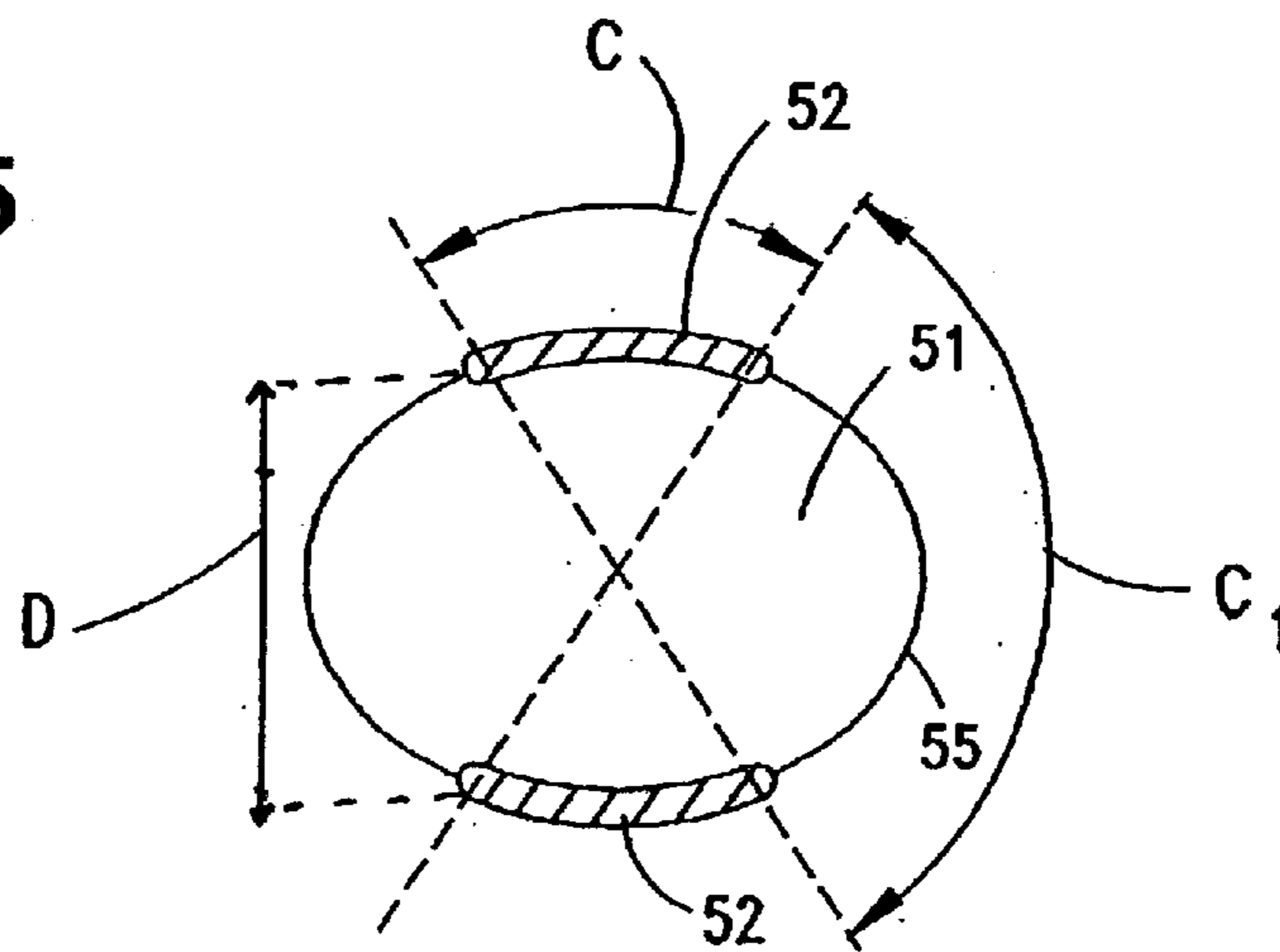
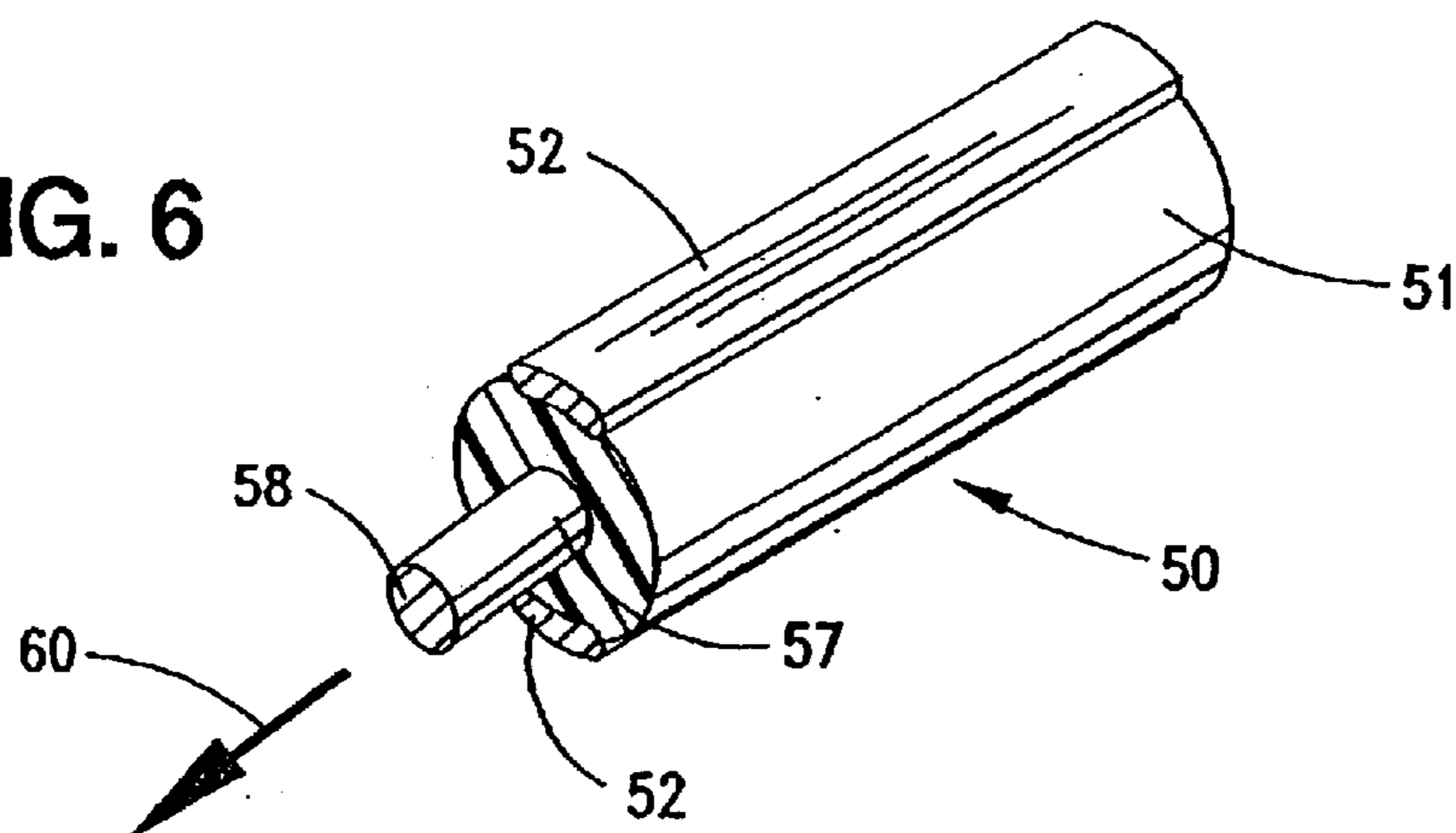


FIG. 6



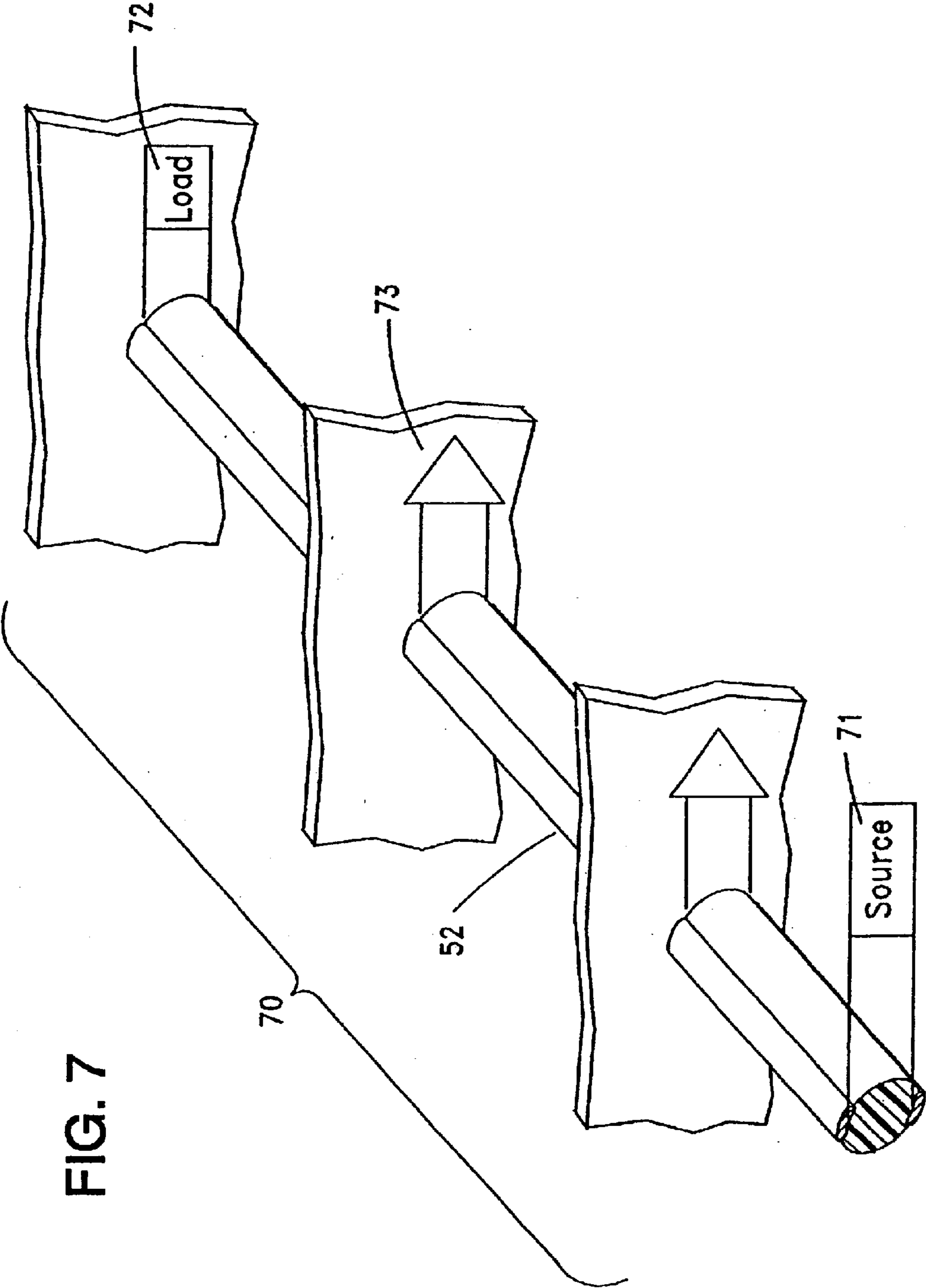


FIG. 7

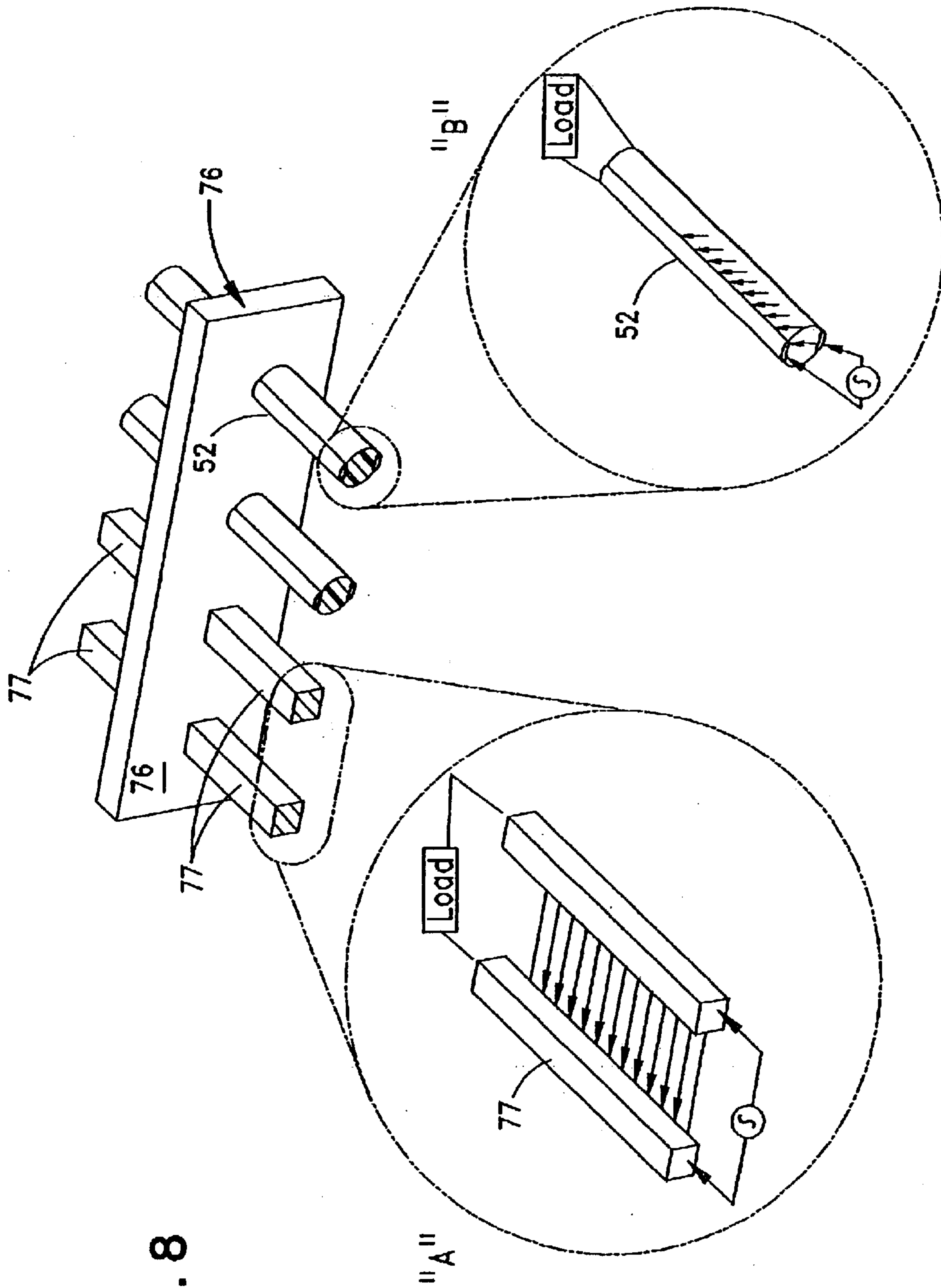


FIG. 8

FIG. 9

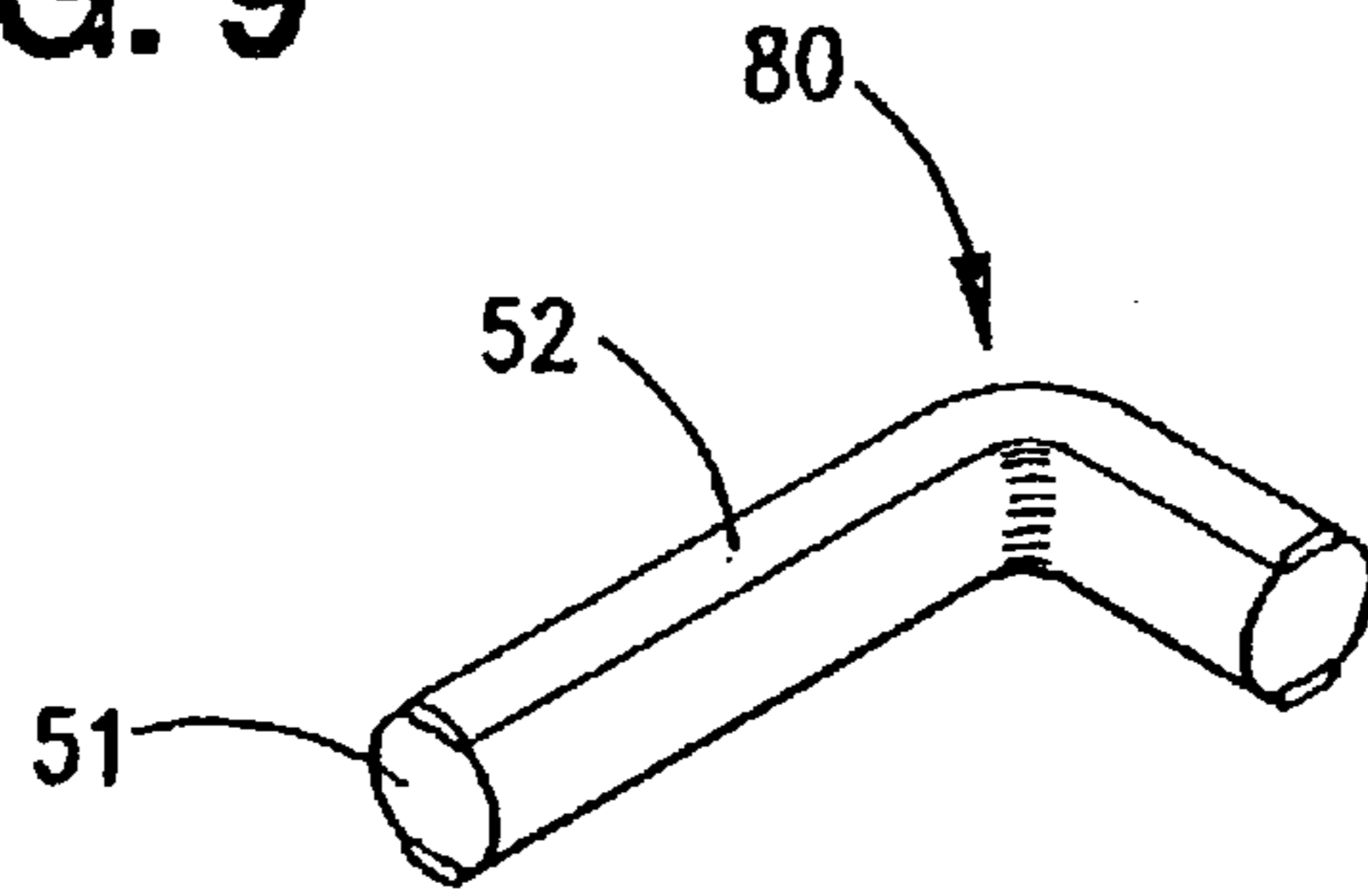


FIG. 10

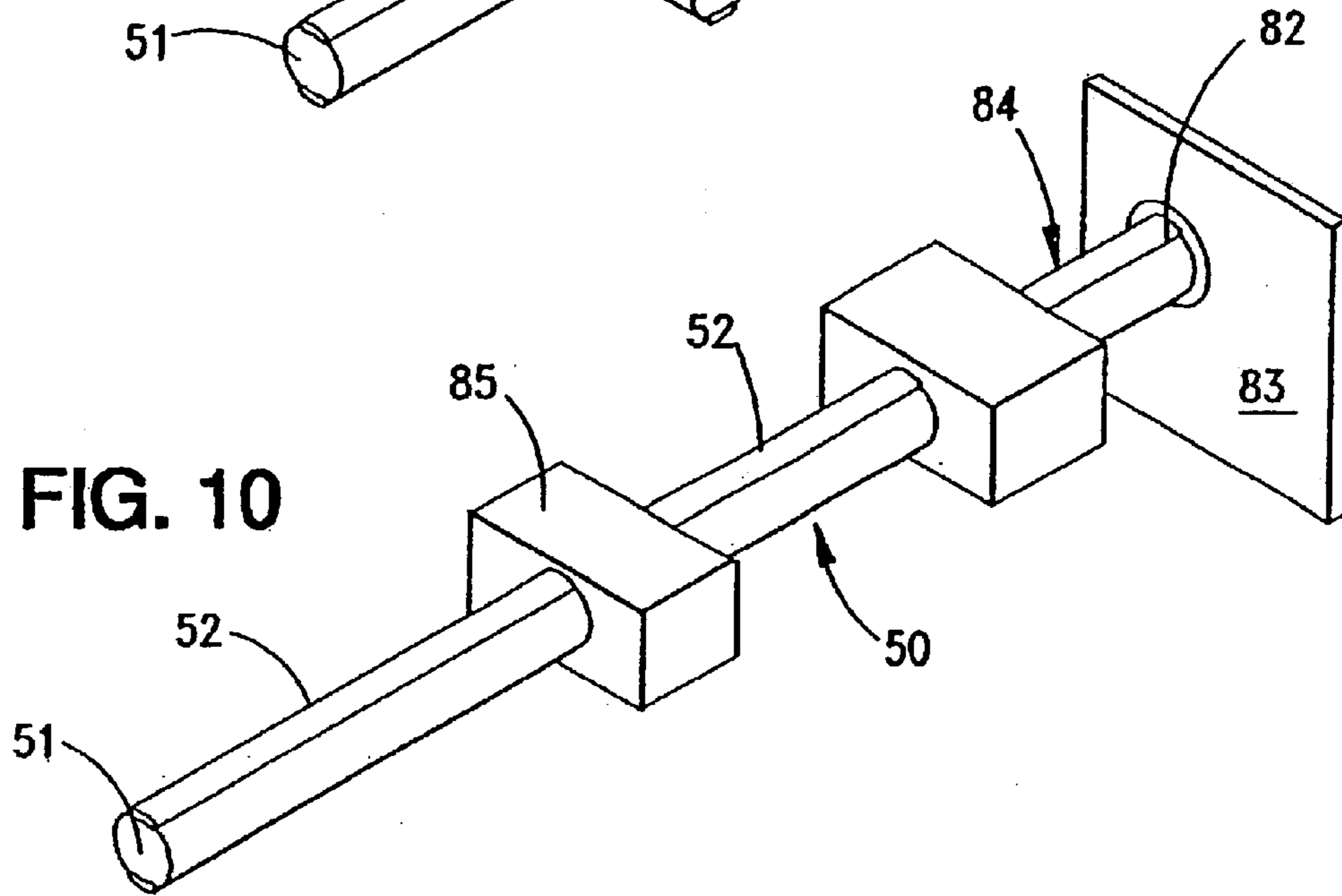


FIG. 11

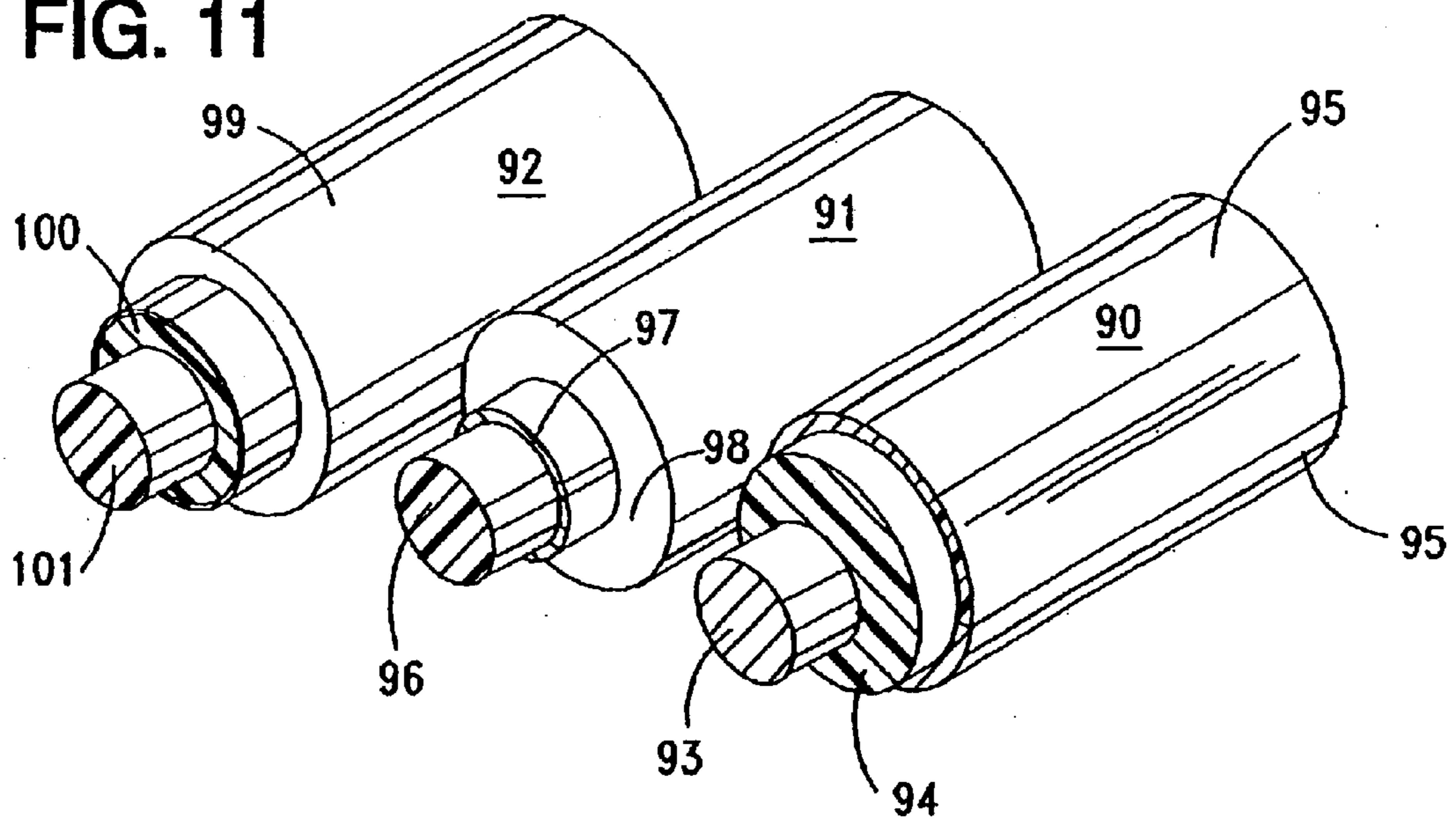


FIG. 12

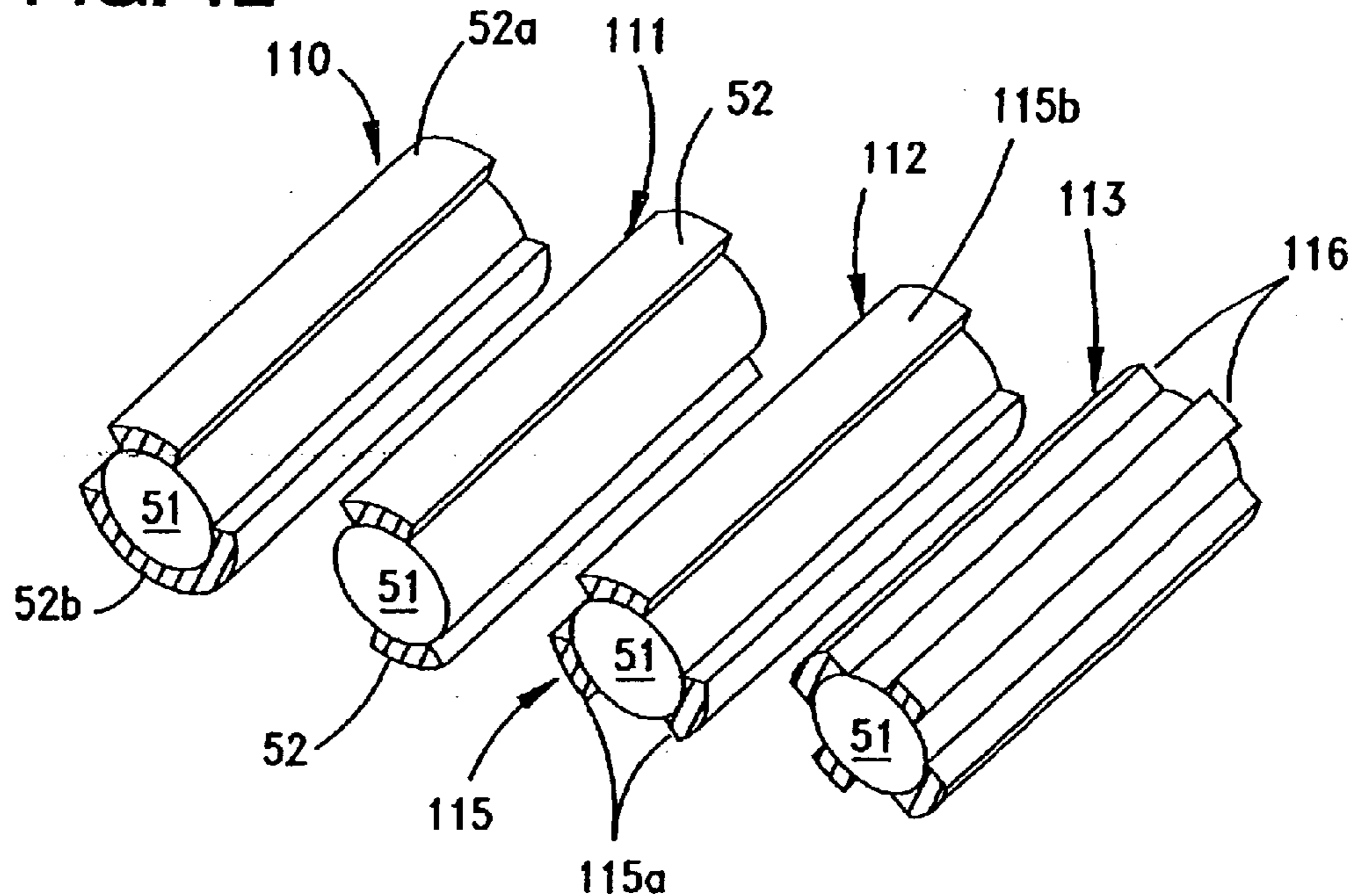


FIG. 13

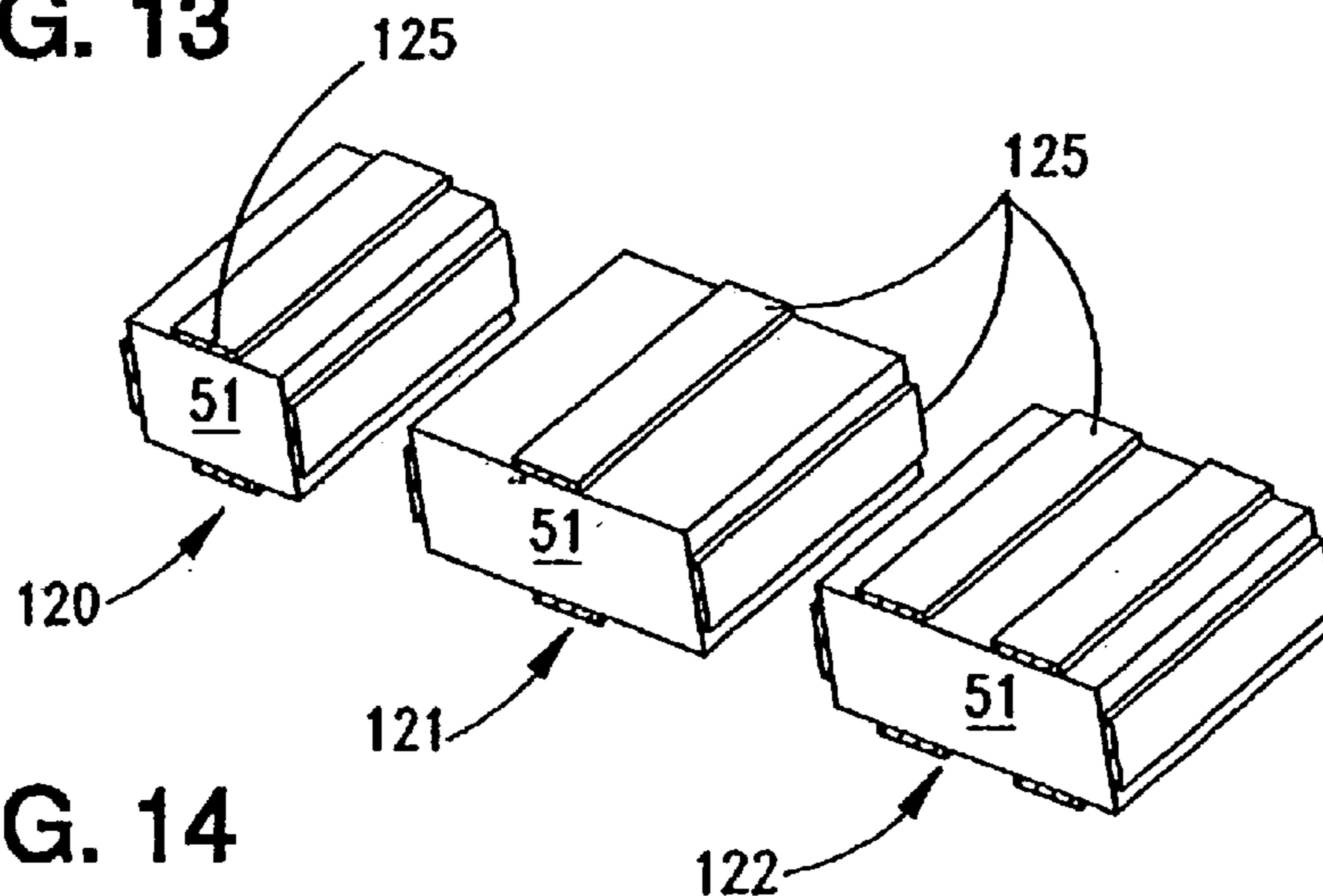
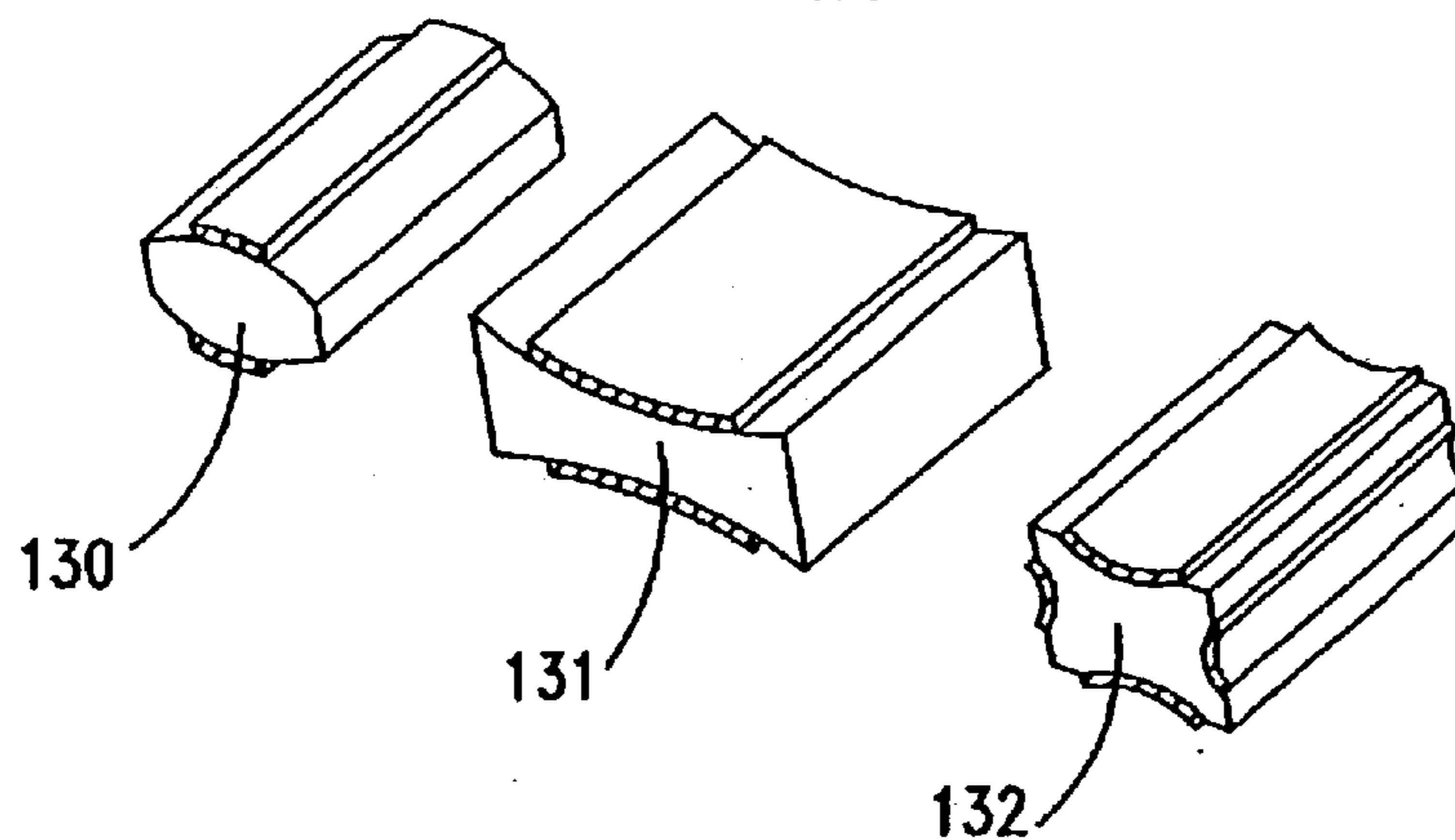


FIG. 14



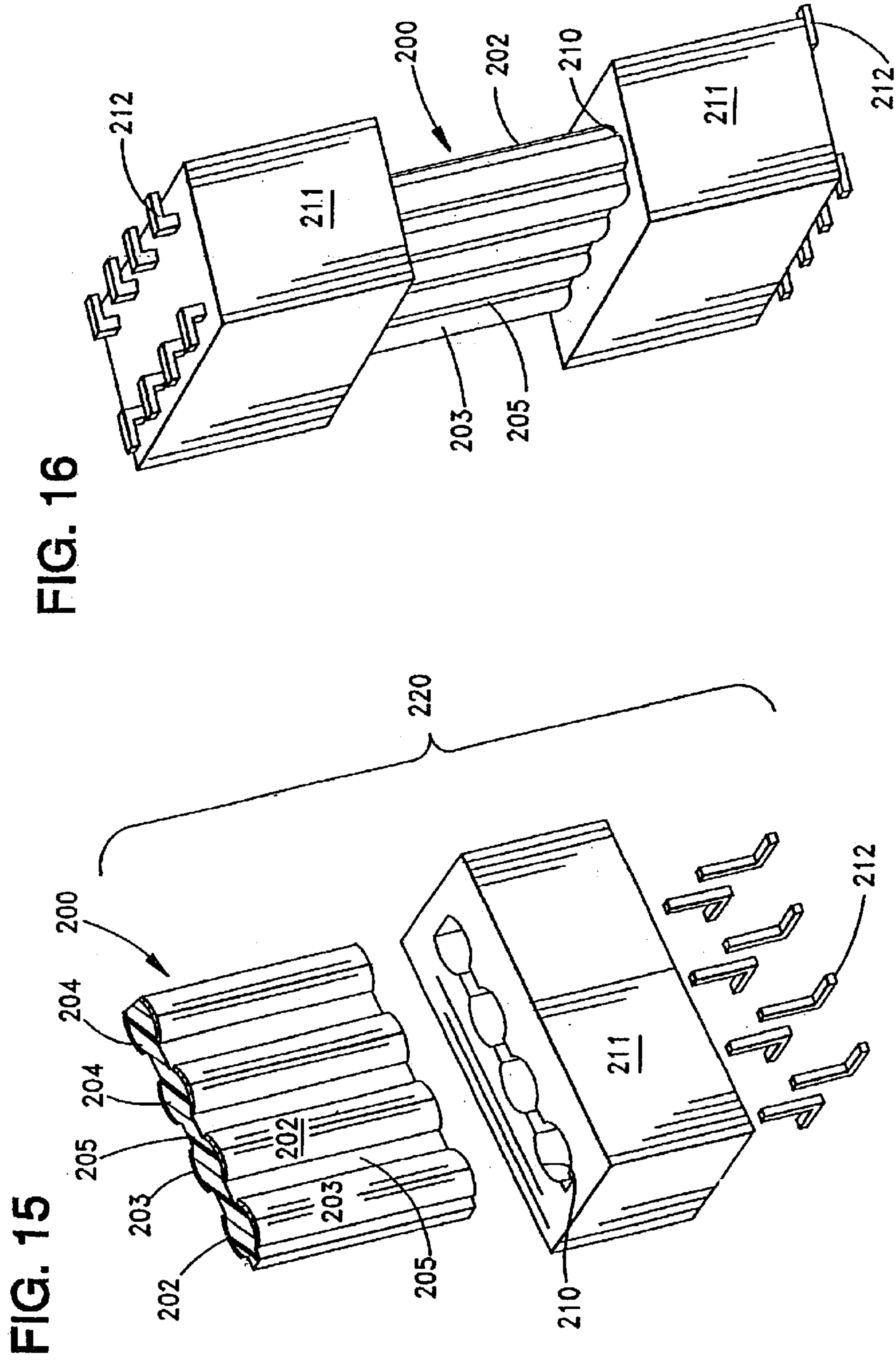


FIG. 17

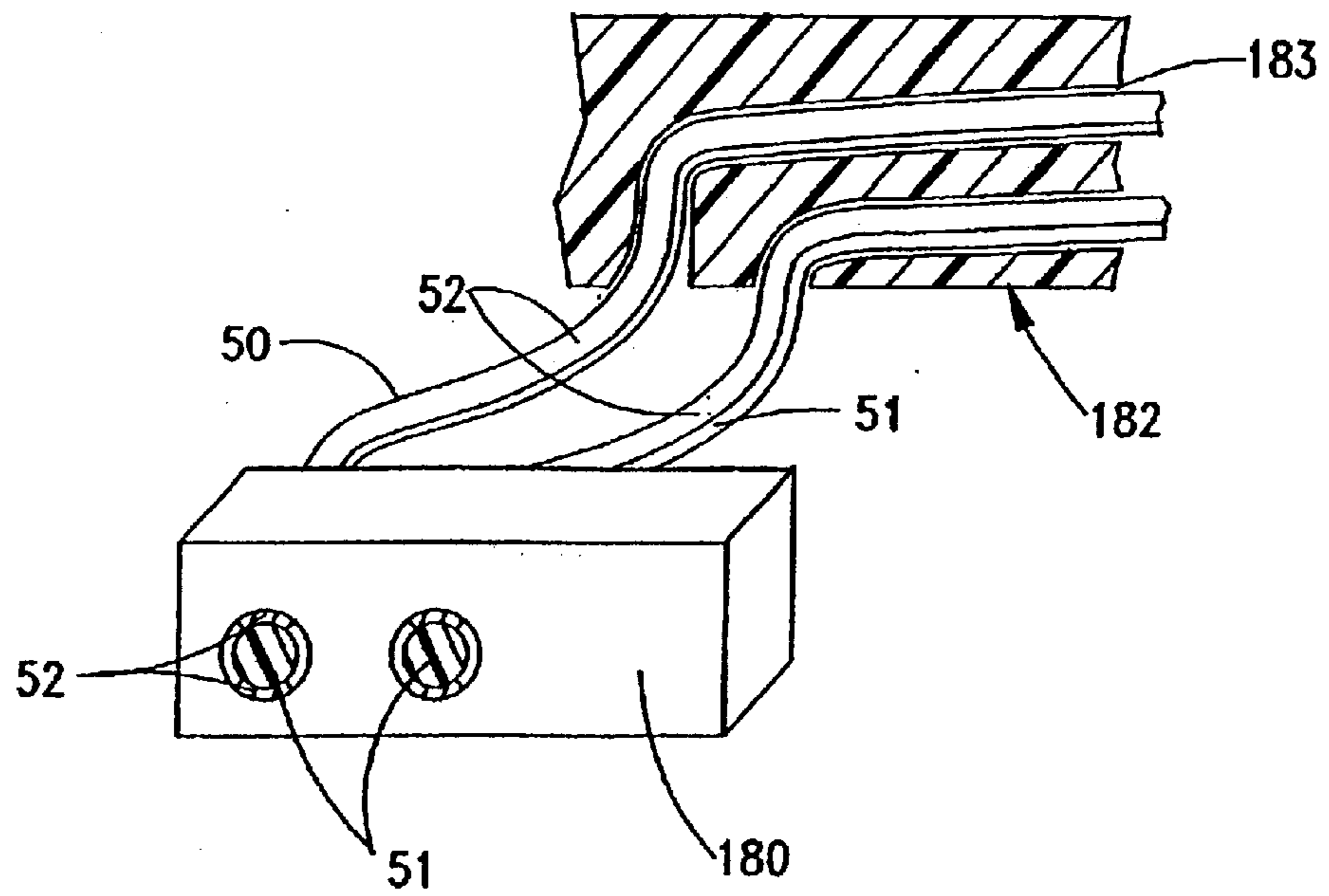


FIG. 18

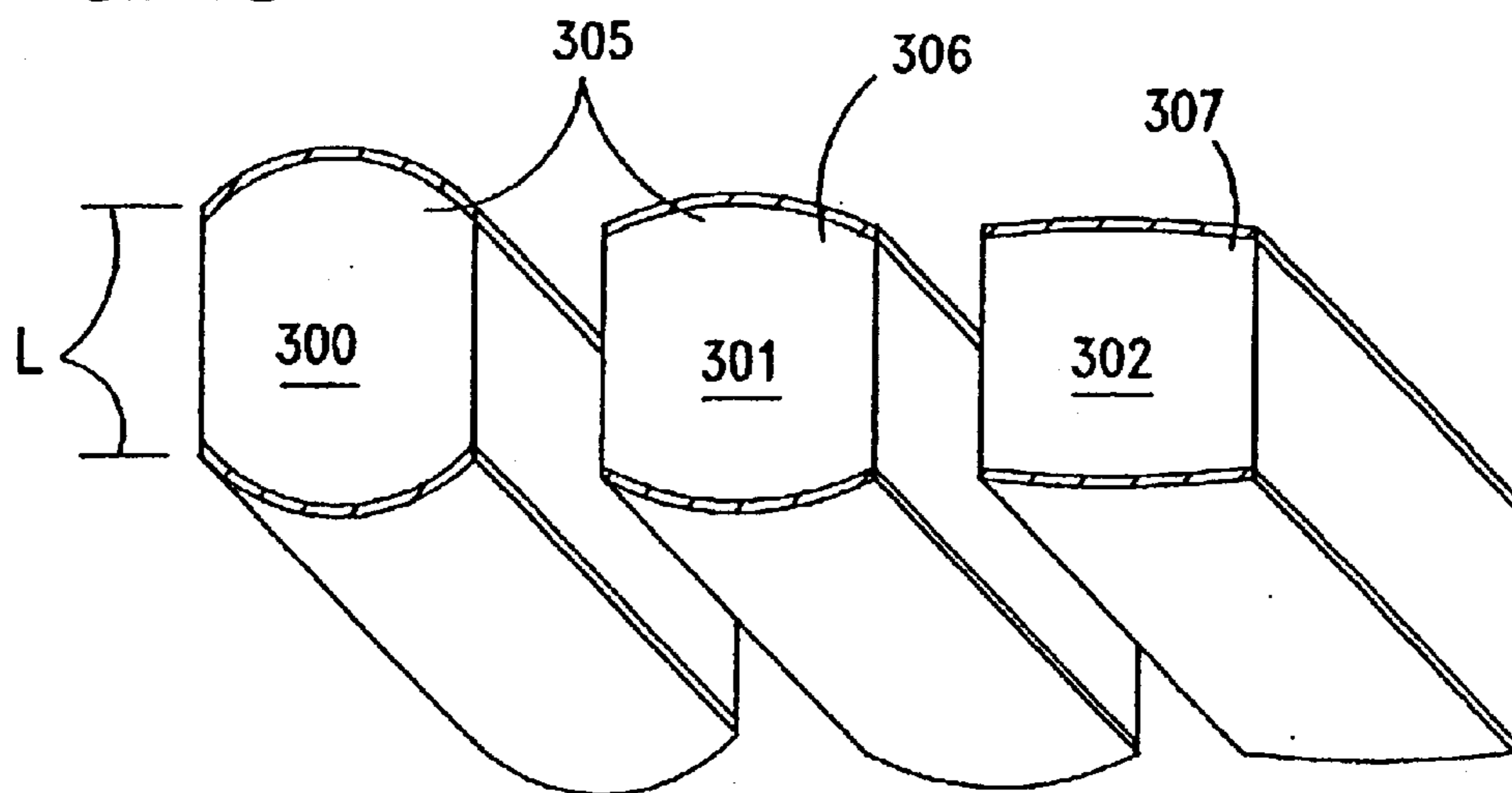


FIG. 19

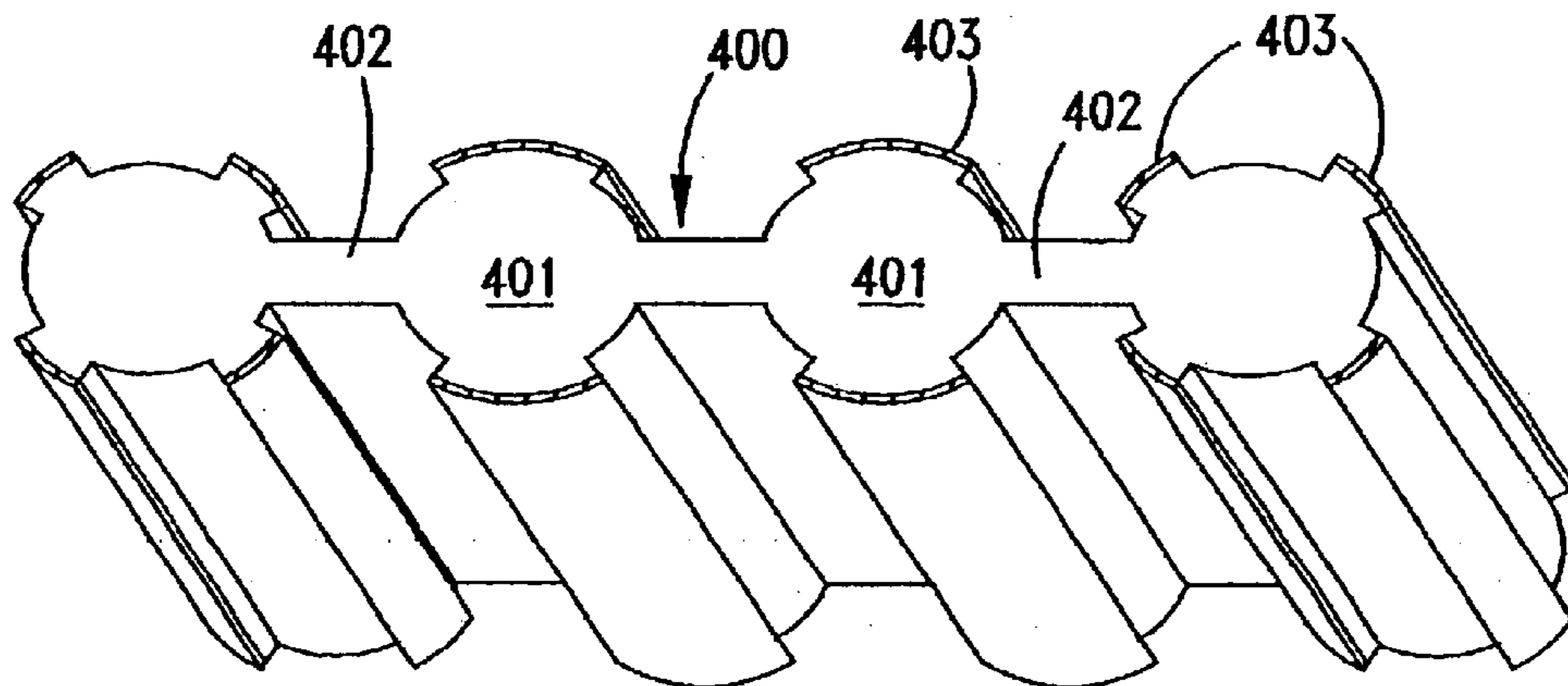


FIG. 20

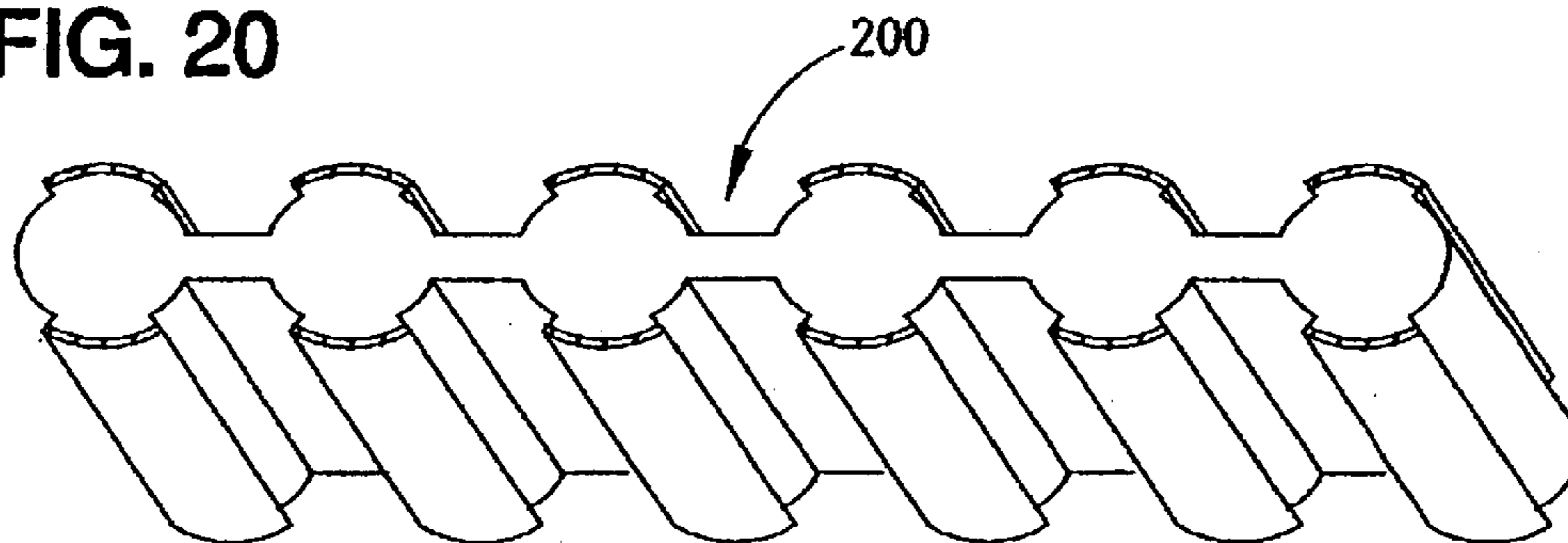


FIG. 21

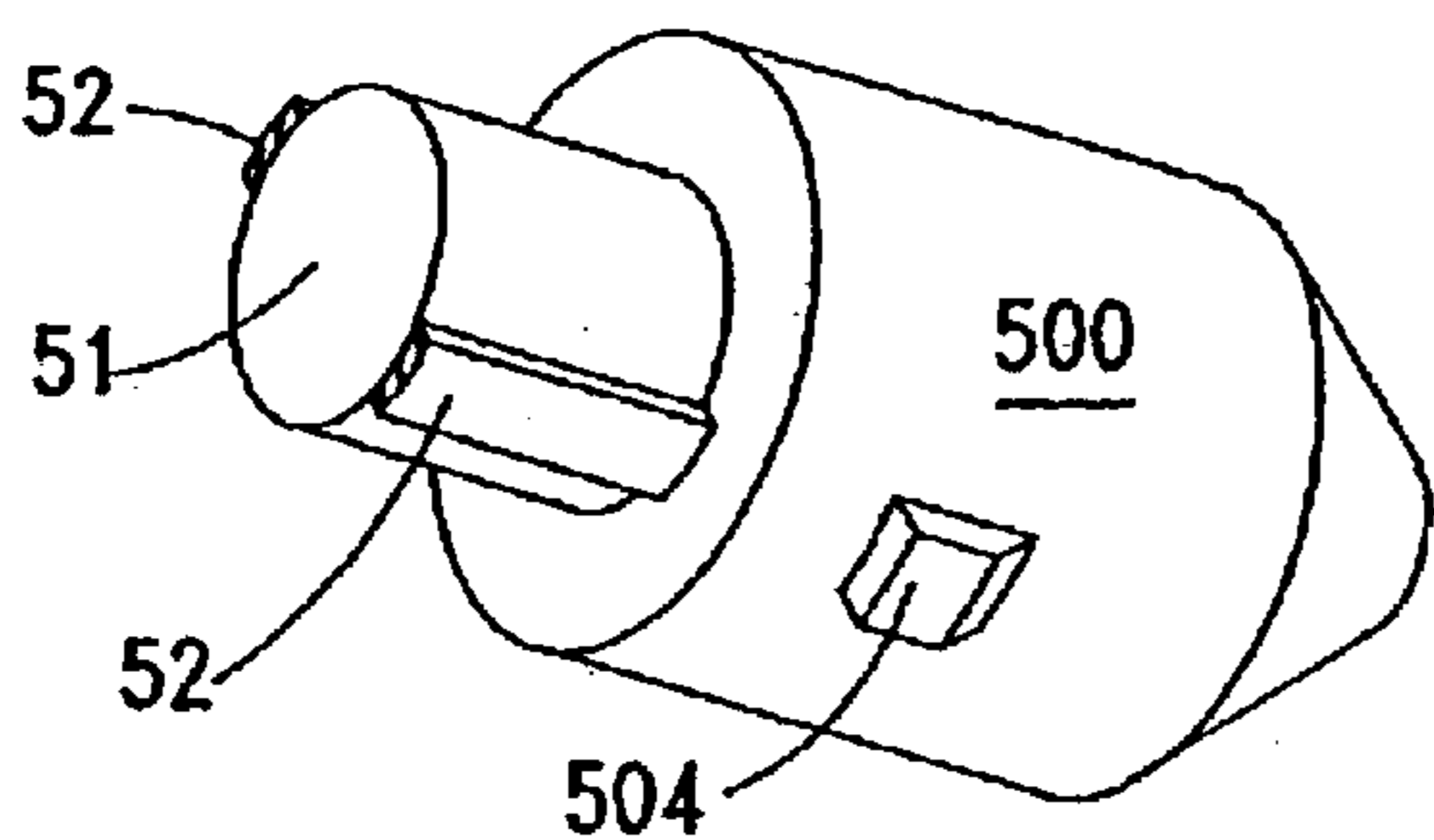


FIG. 22

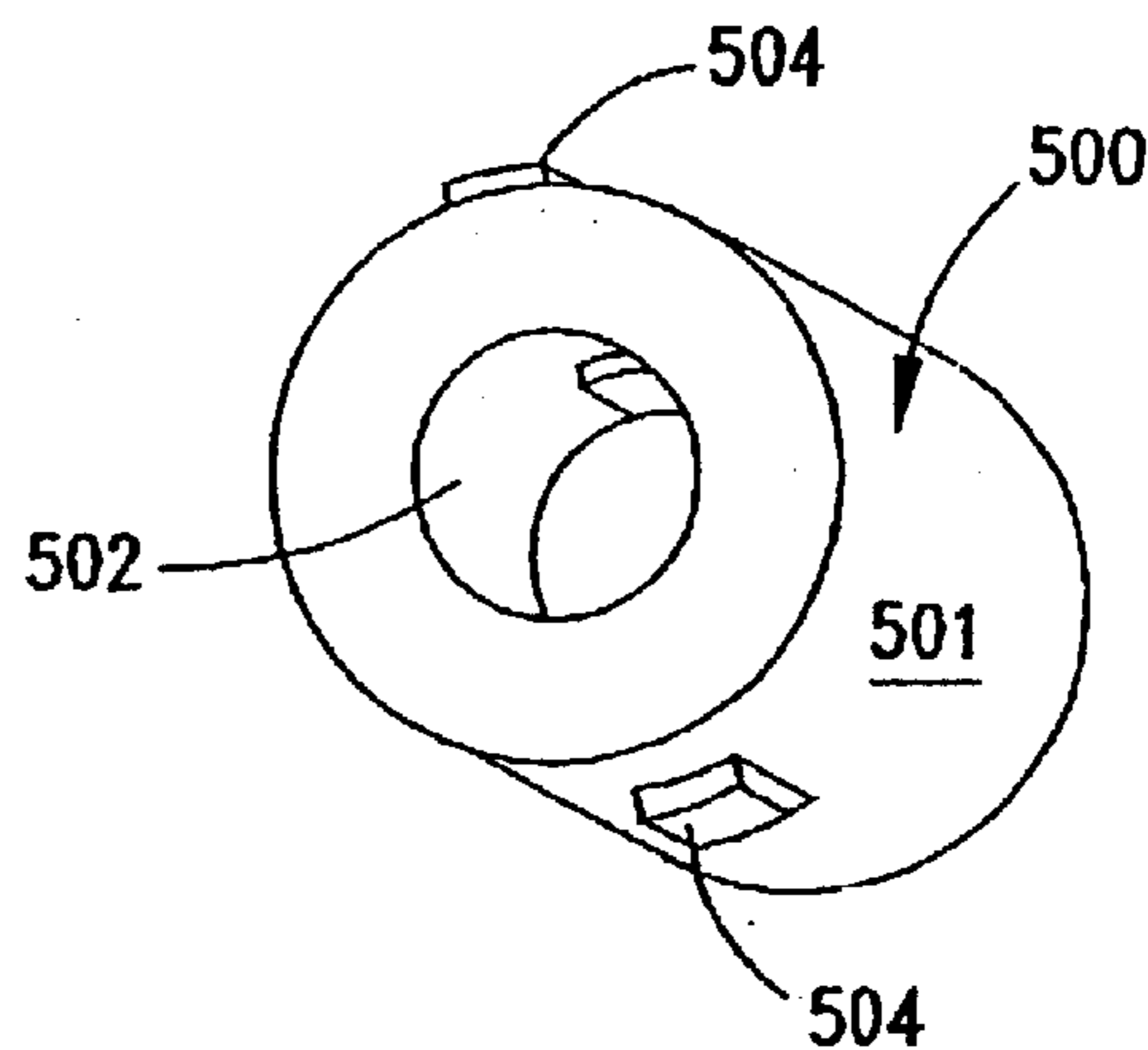


FIG. 23

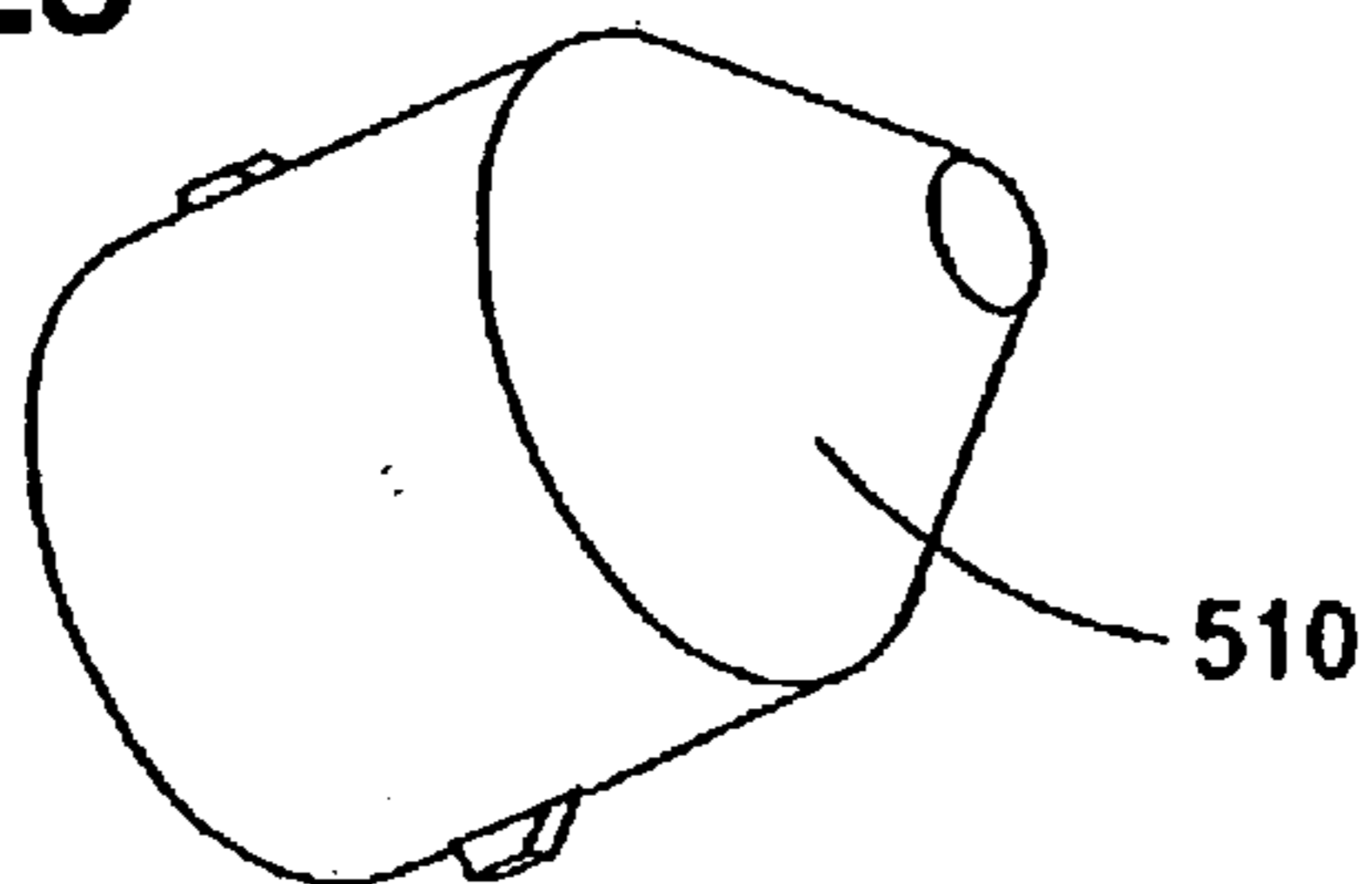


FIG. 24

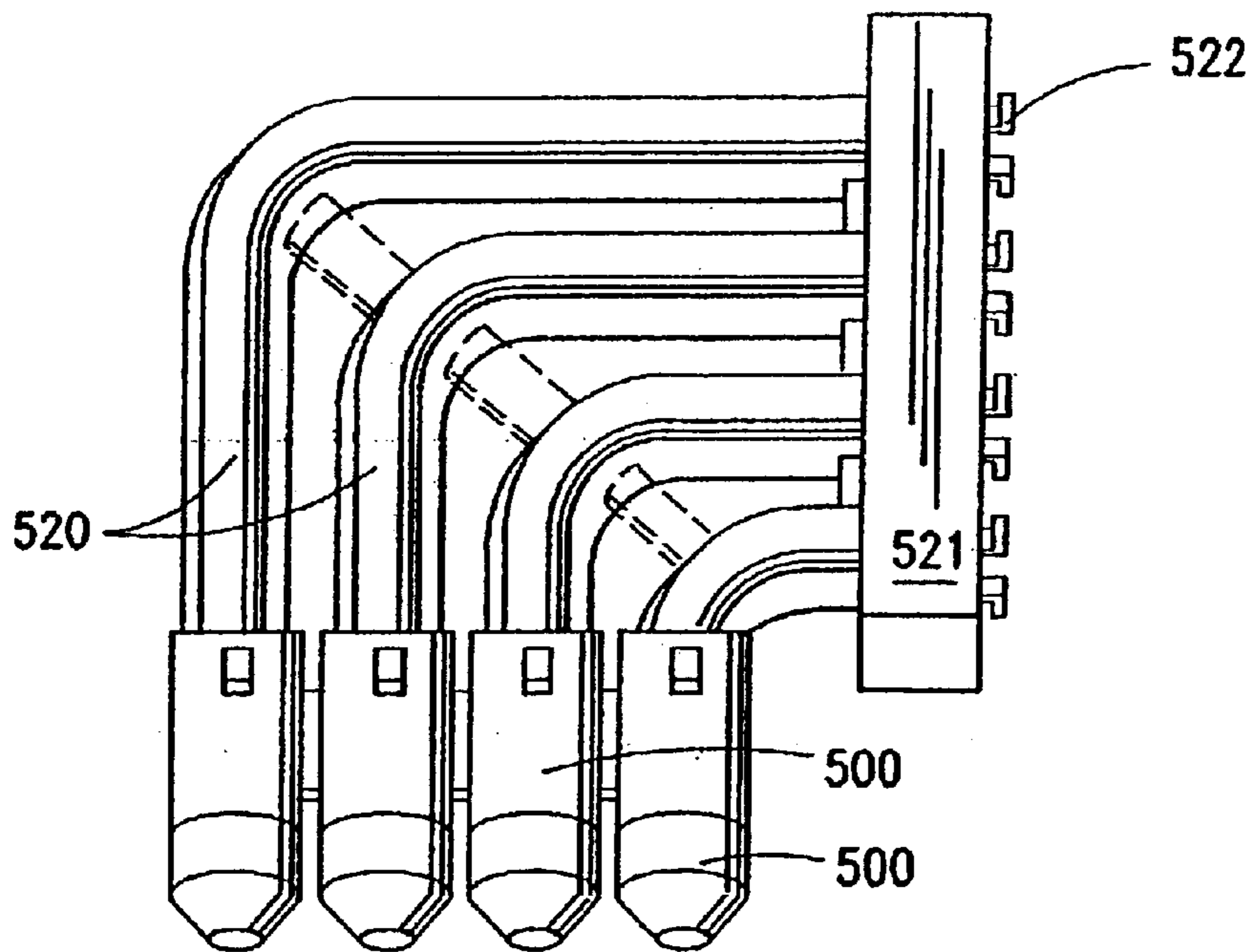


FIG. 25

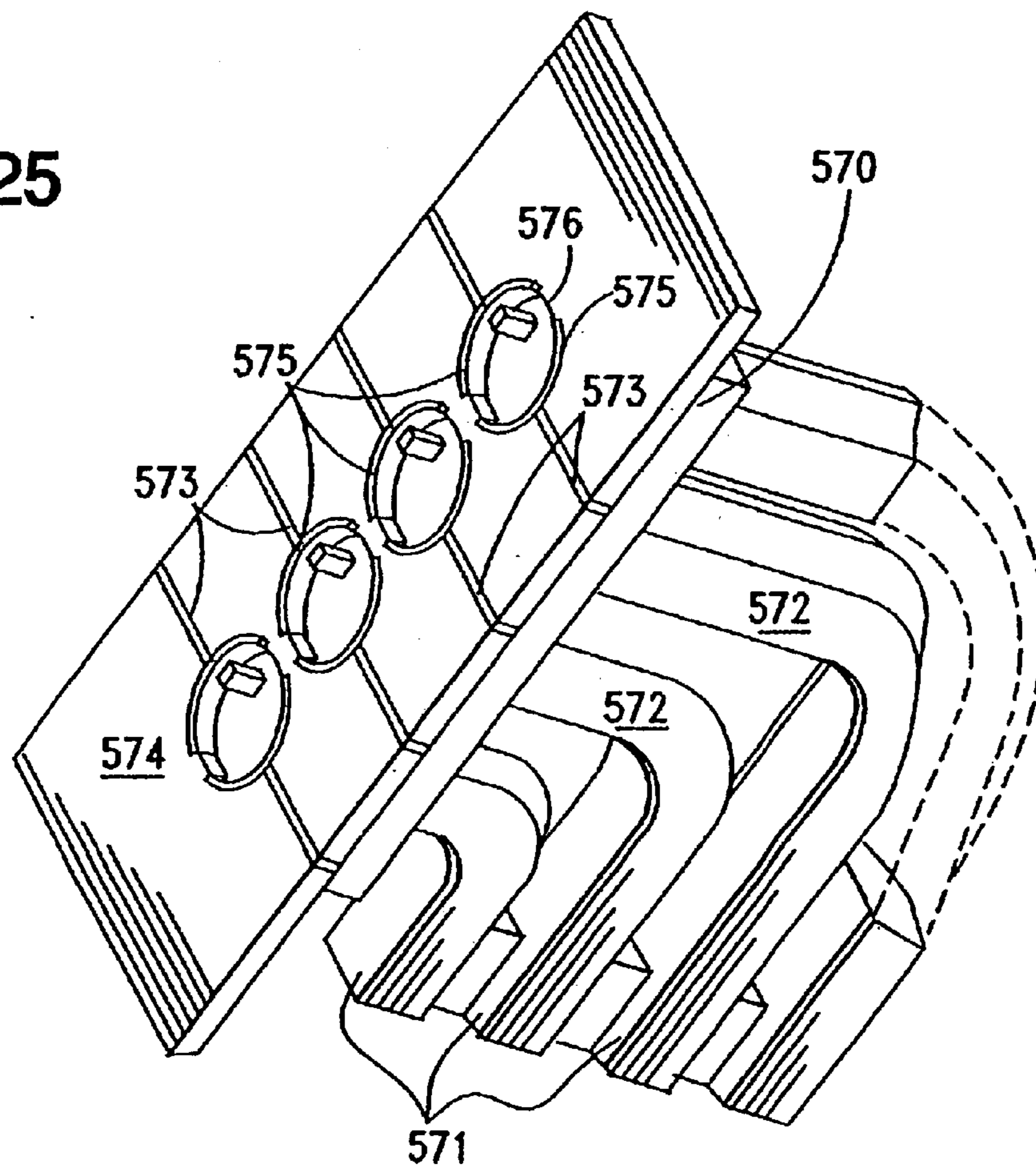


FIG. 26

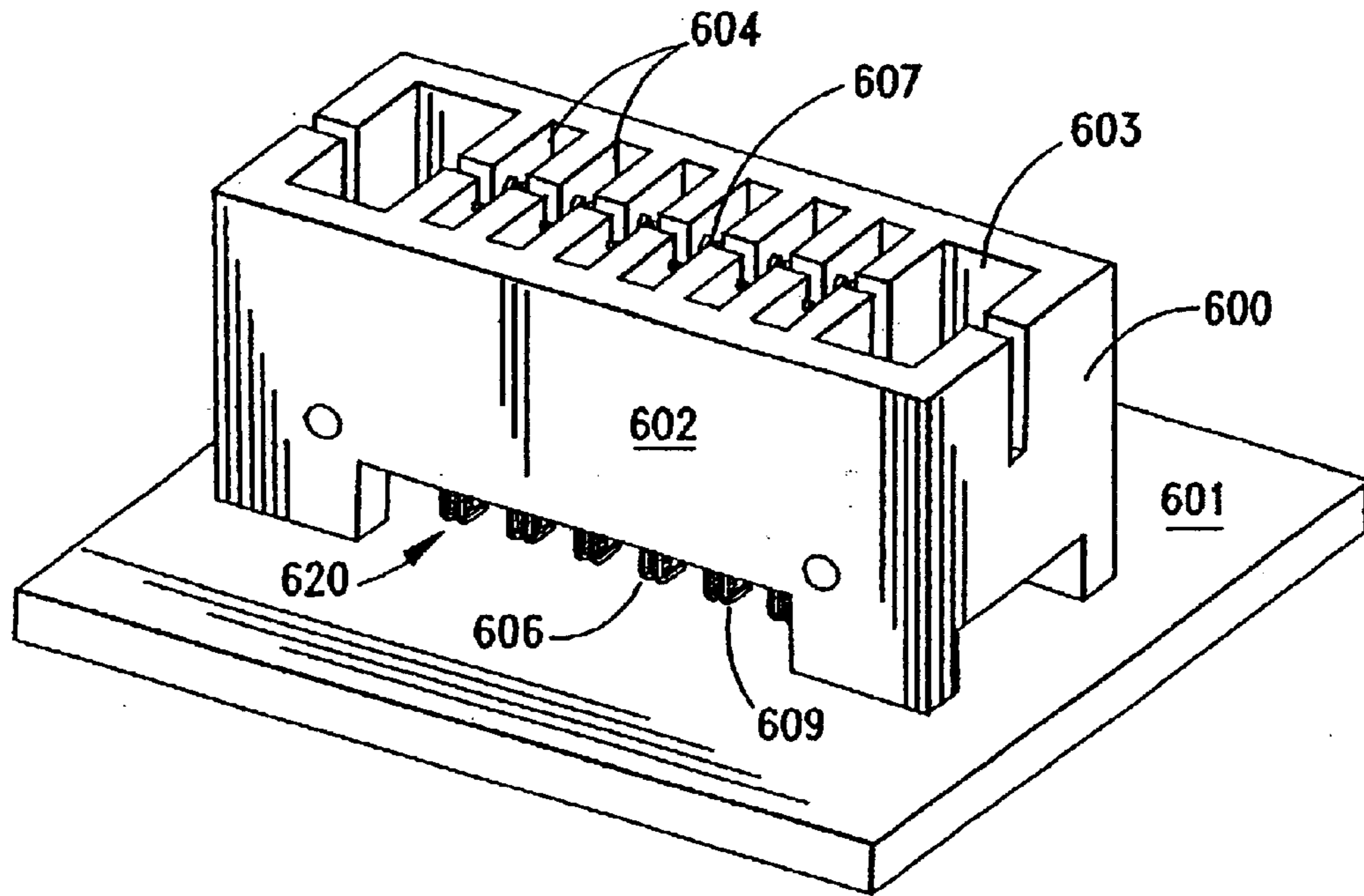


FIG. 27A

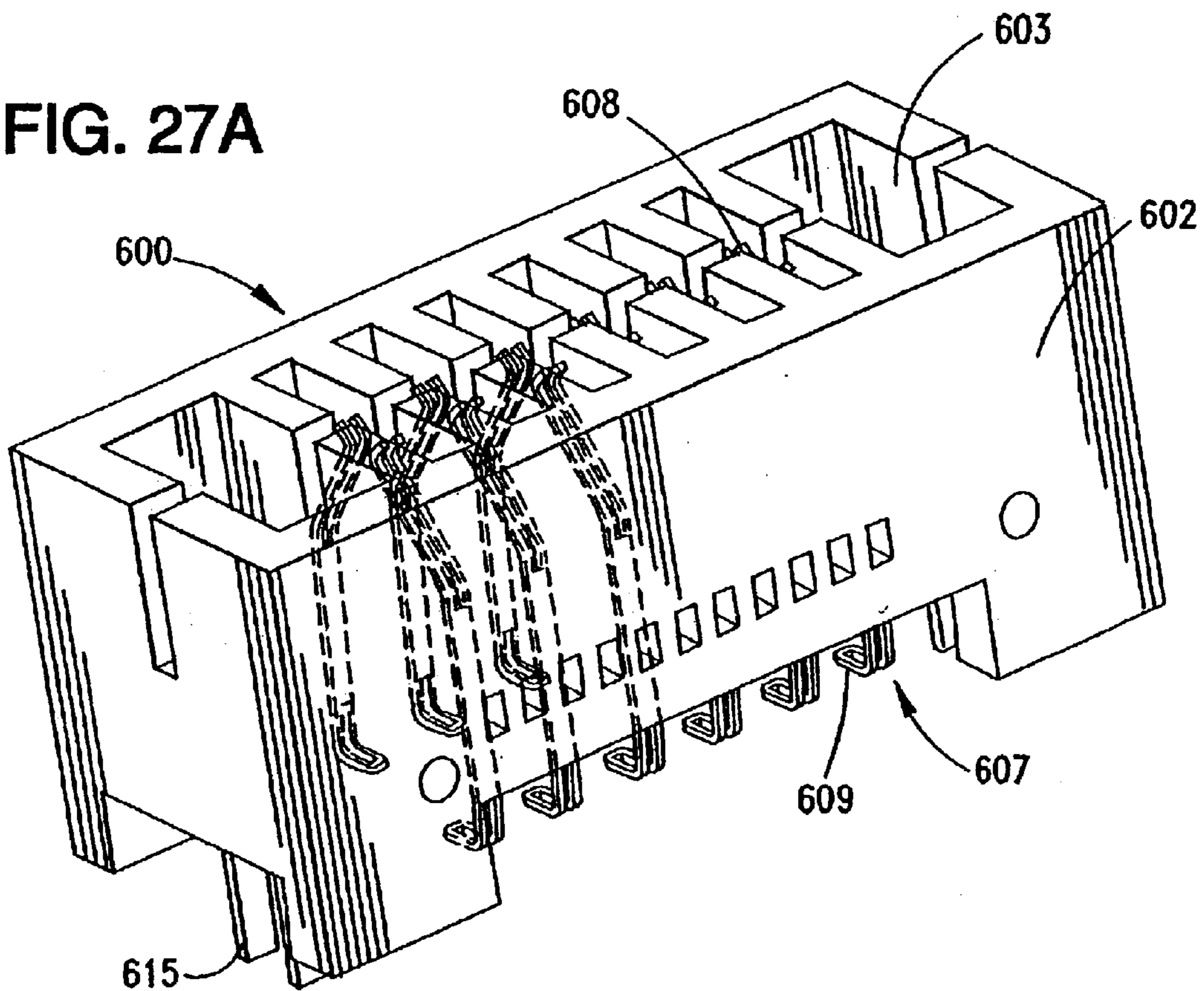


FIG. 27B

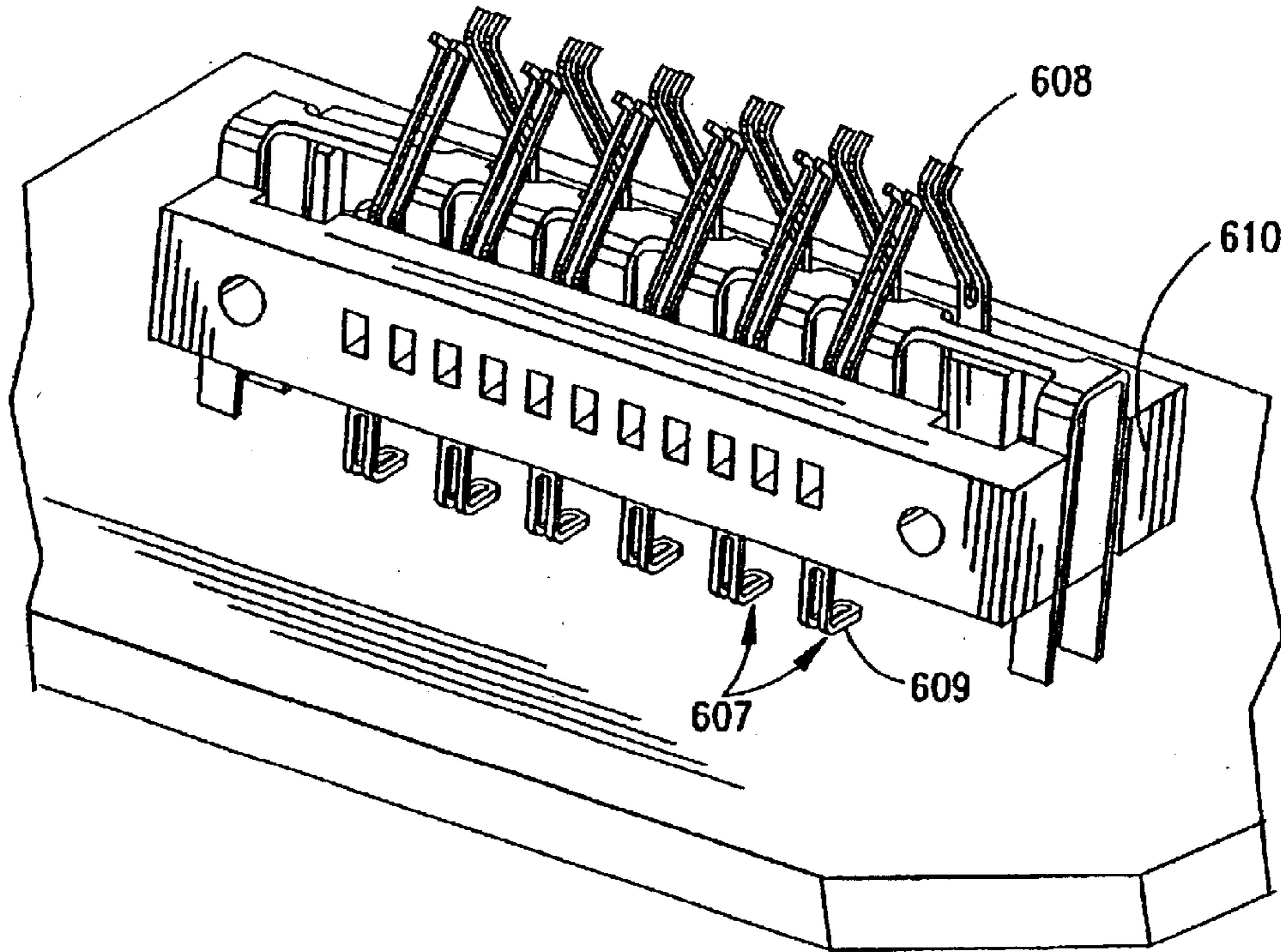


FIG. 28

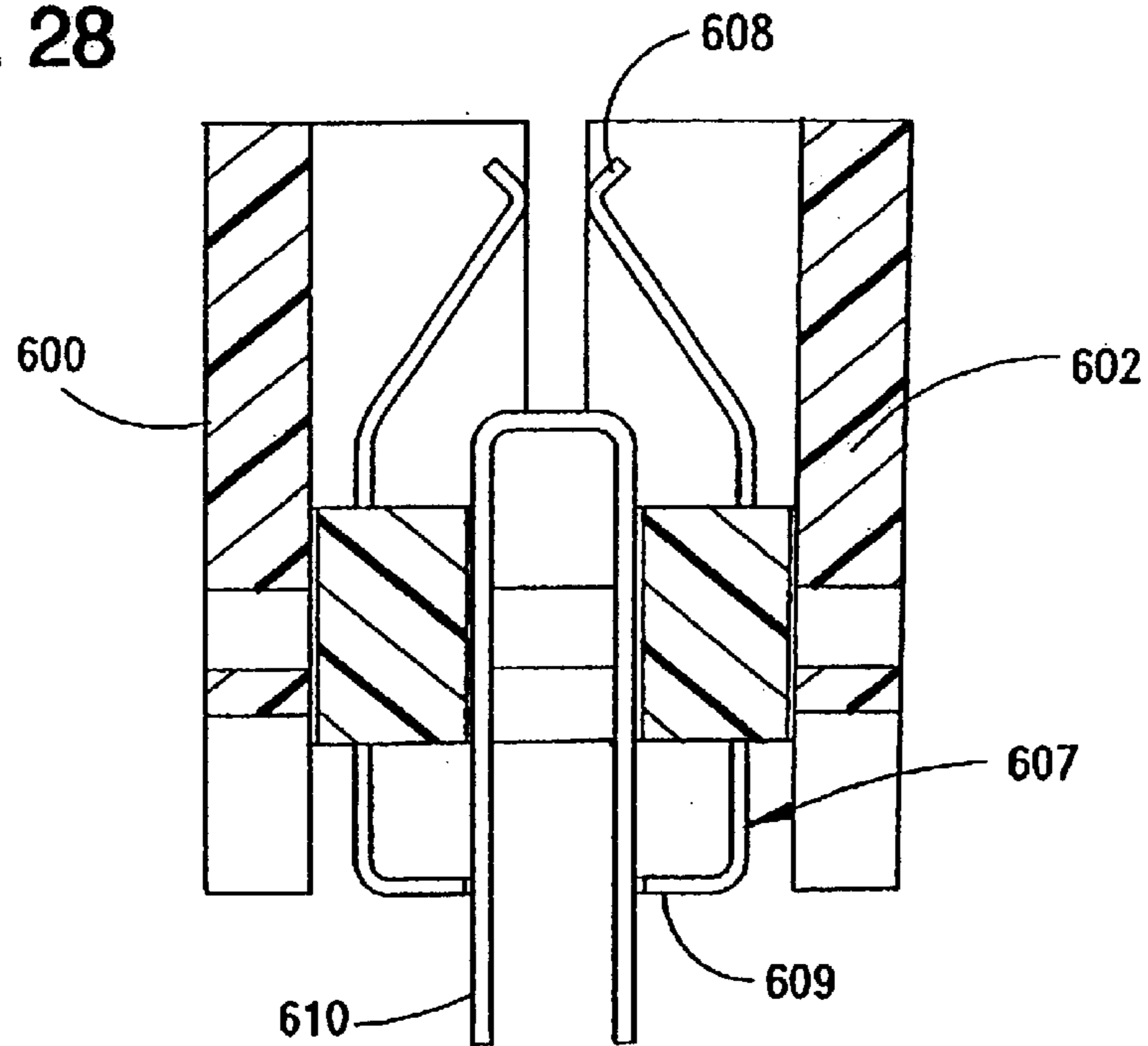


FIG. 29A

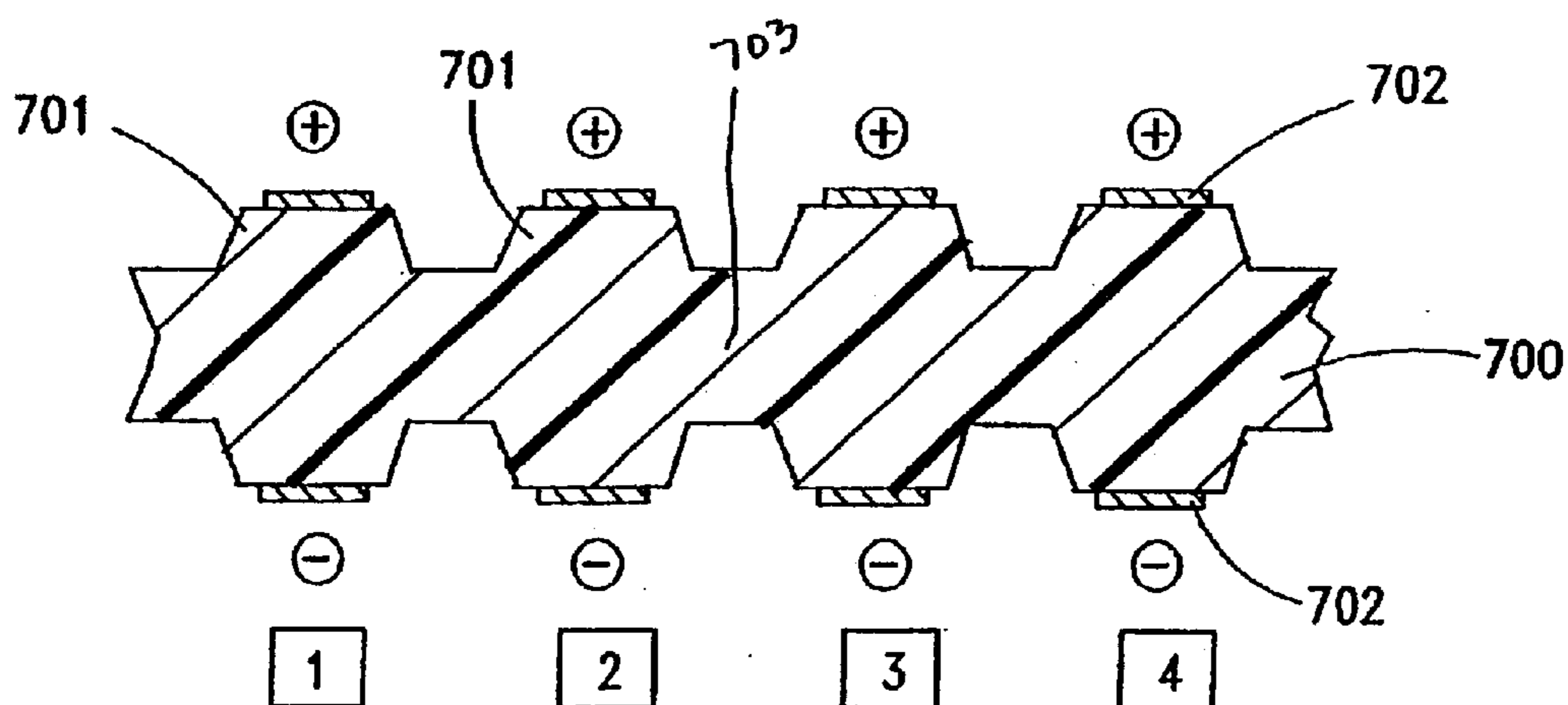


FIG. 29B

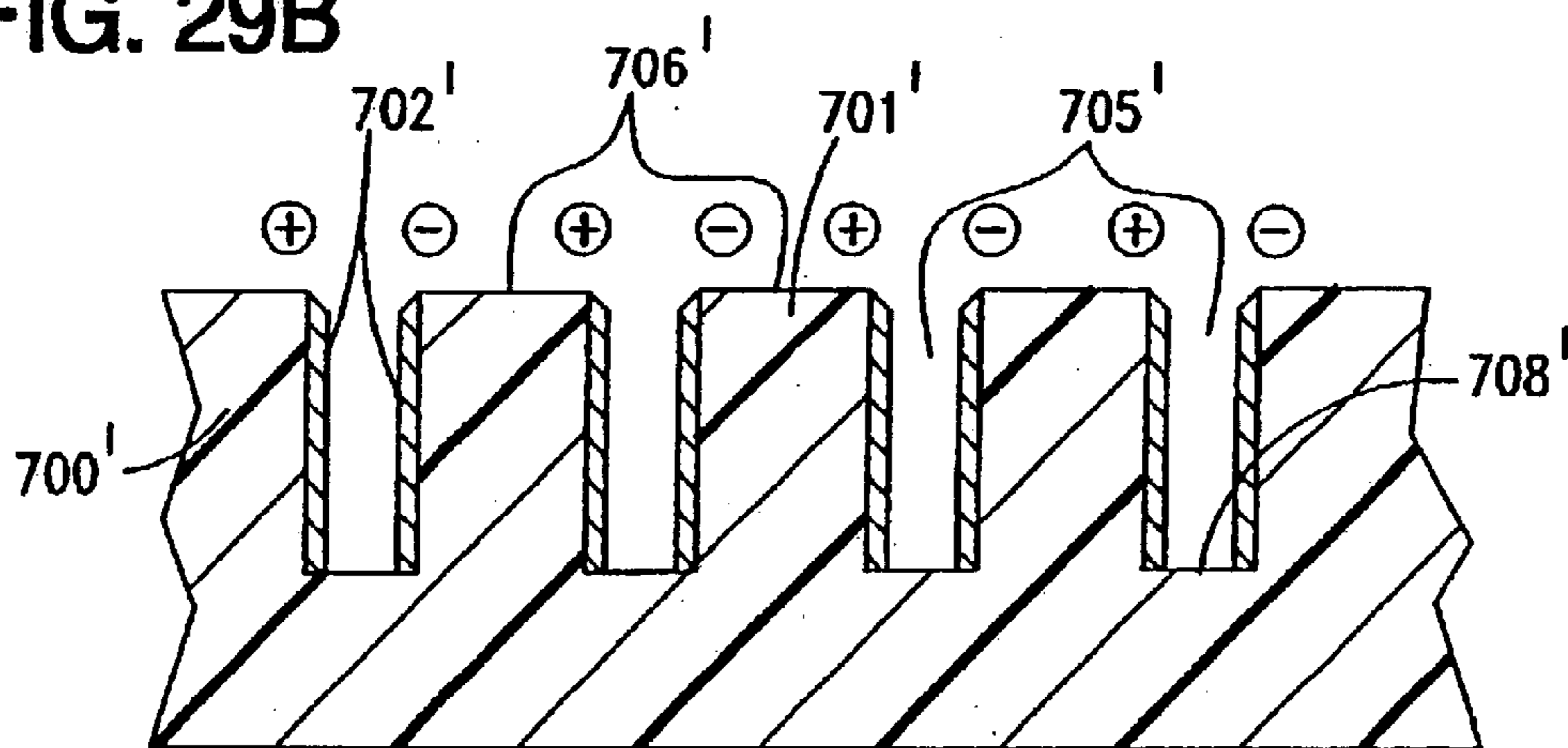


FIG. 29C

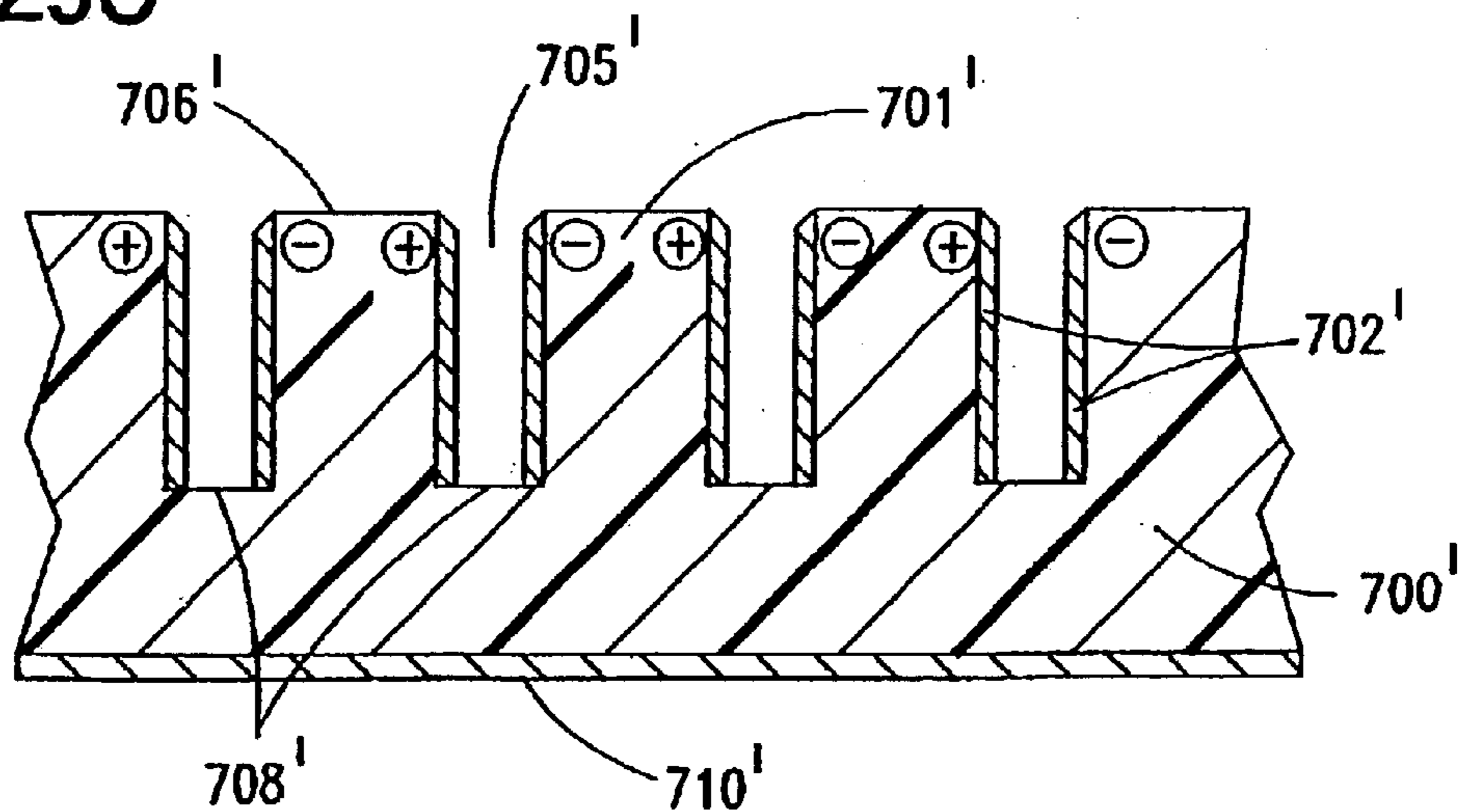


FIG. 30

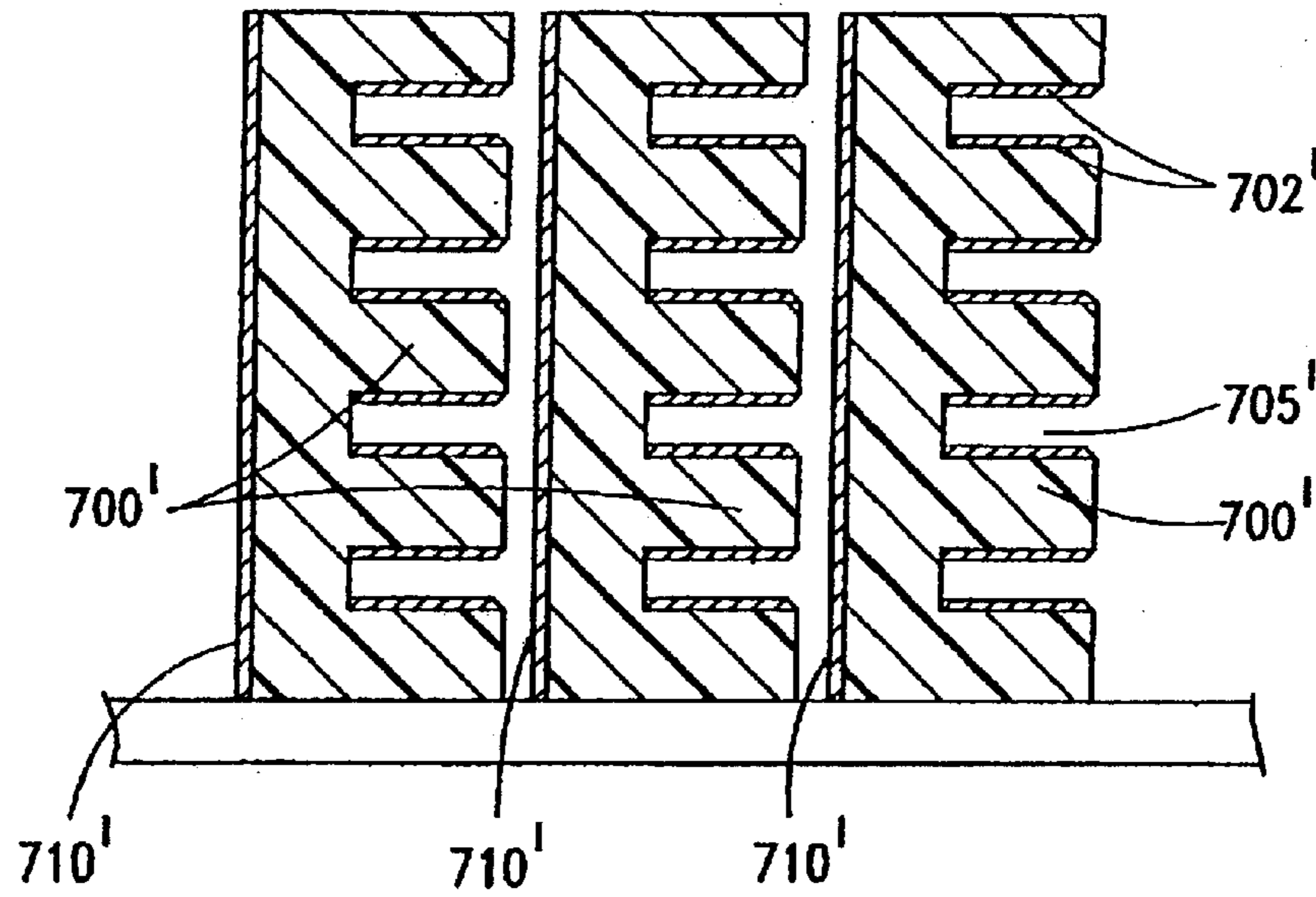


FIG. 31

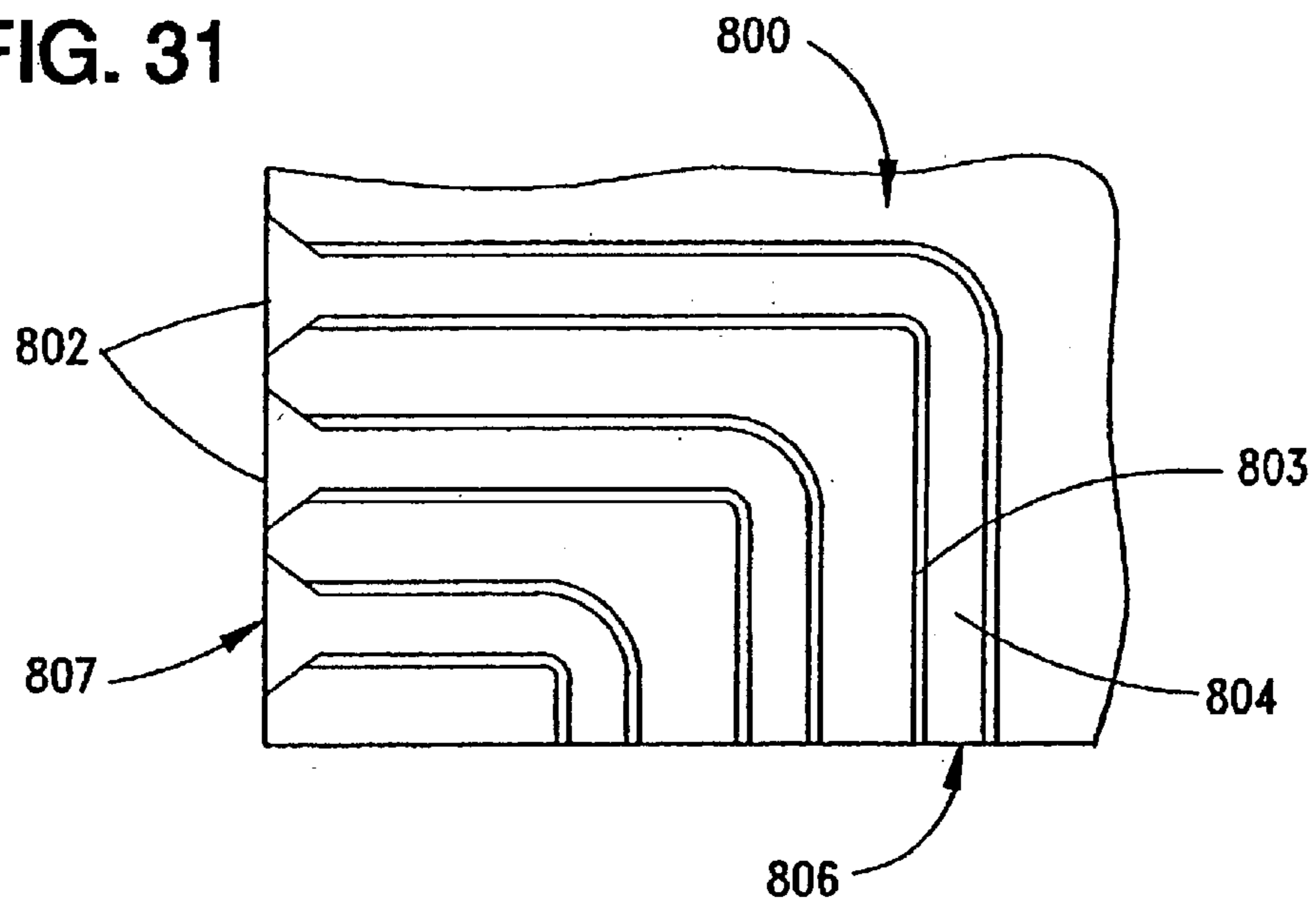


FIG. 32

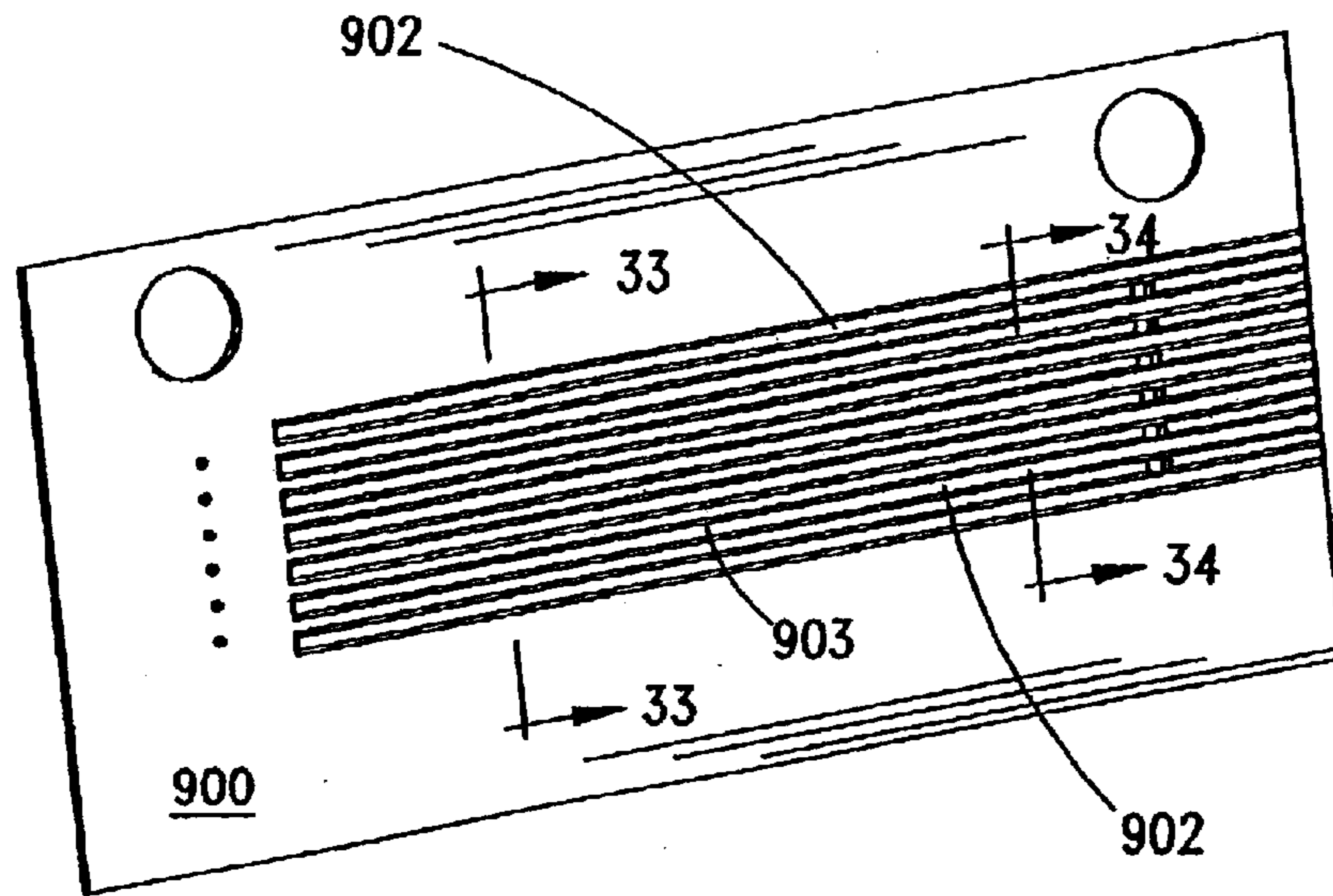


FIG. 33

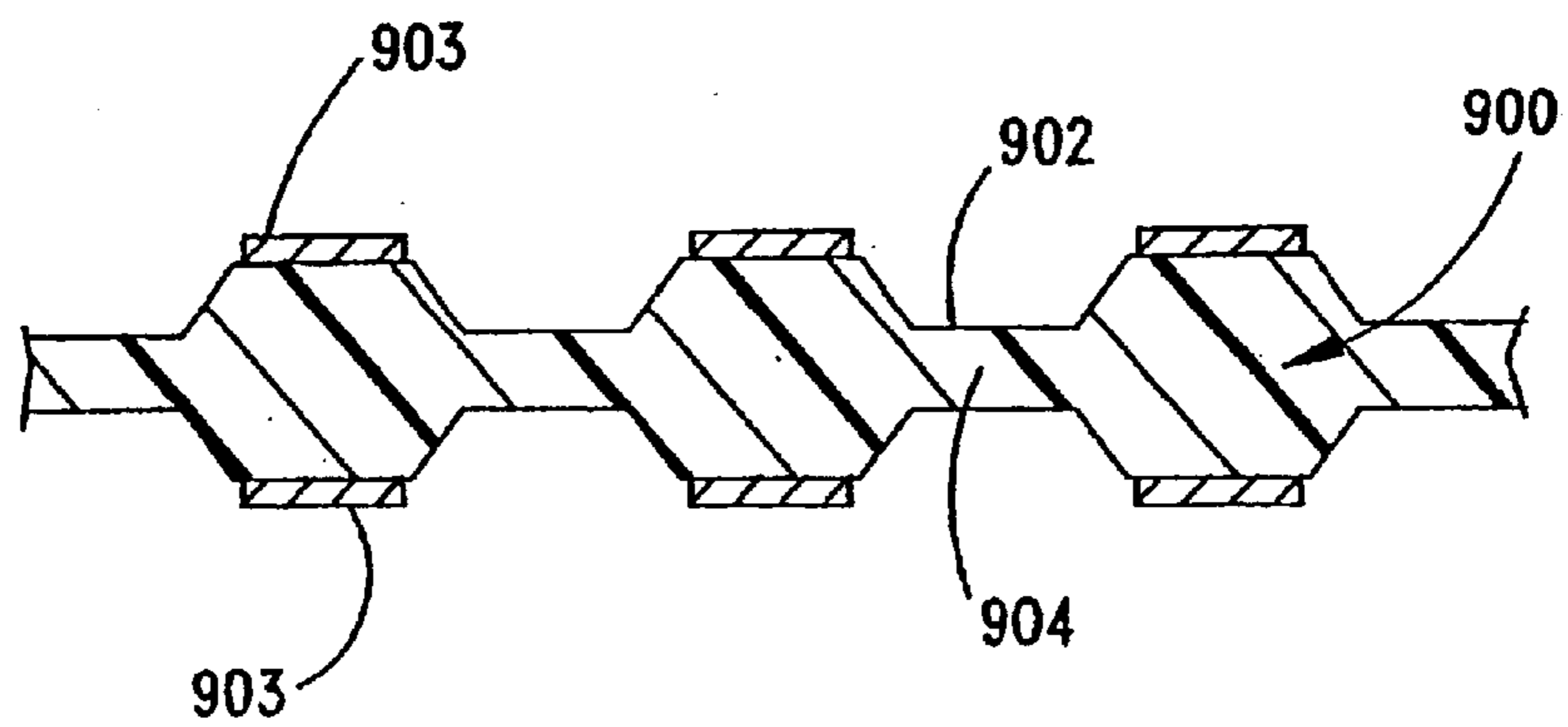


FIG. 34

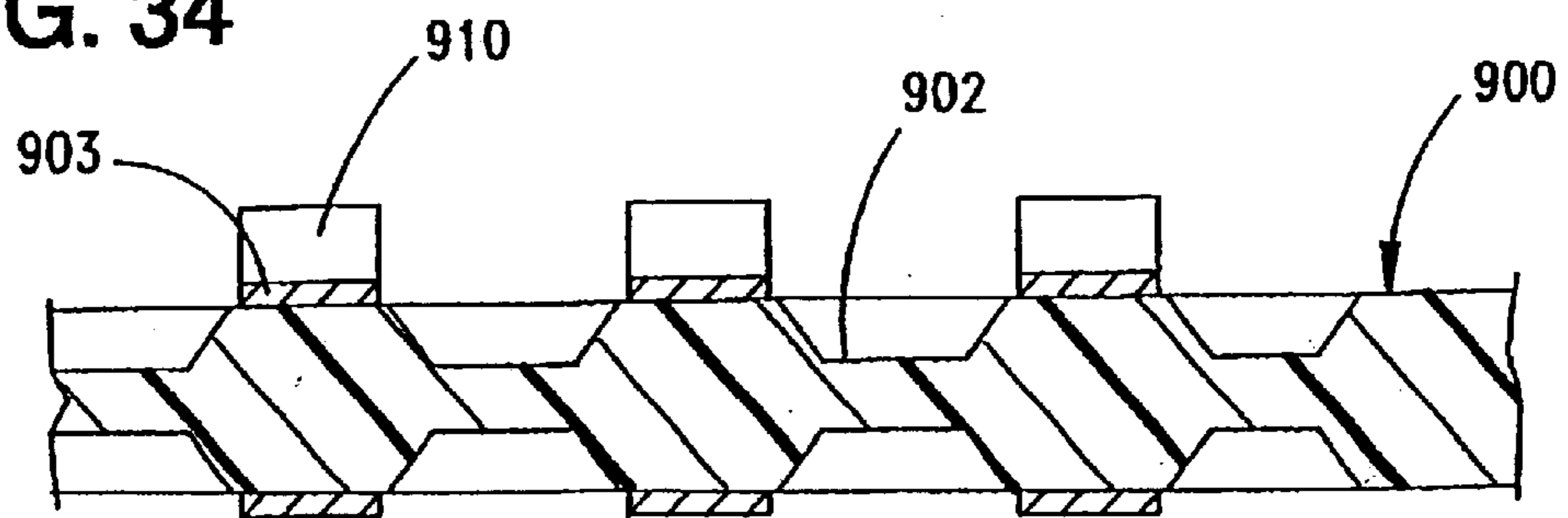


FIG. 35

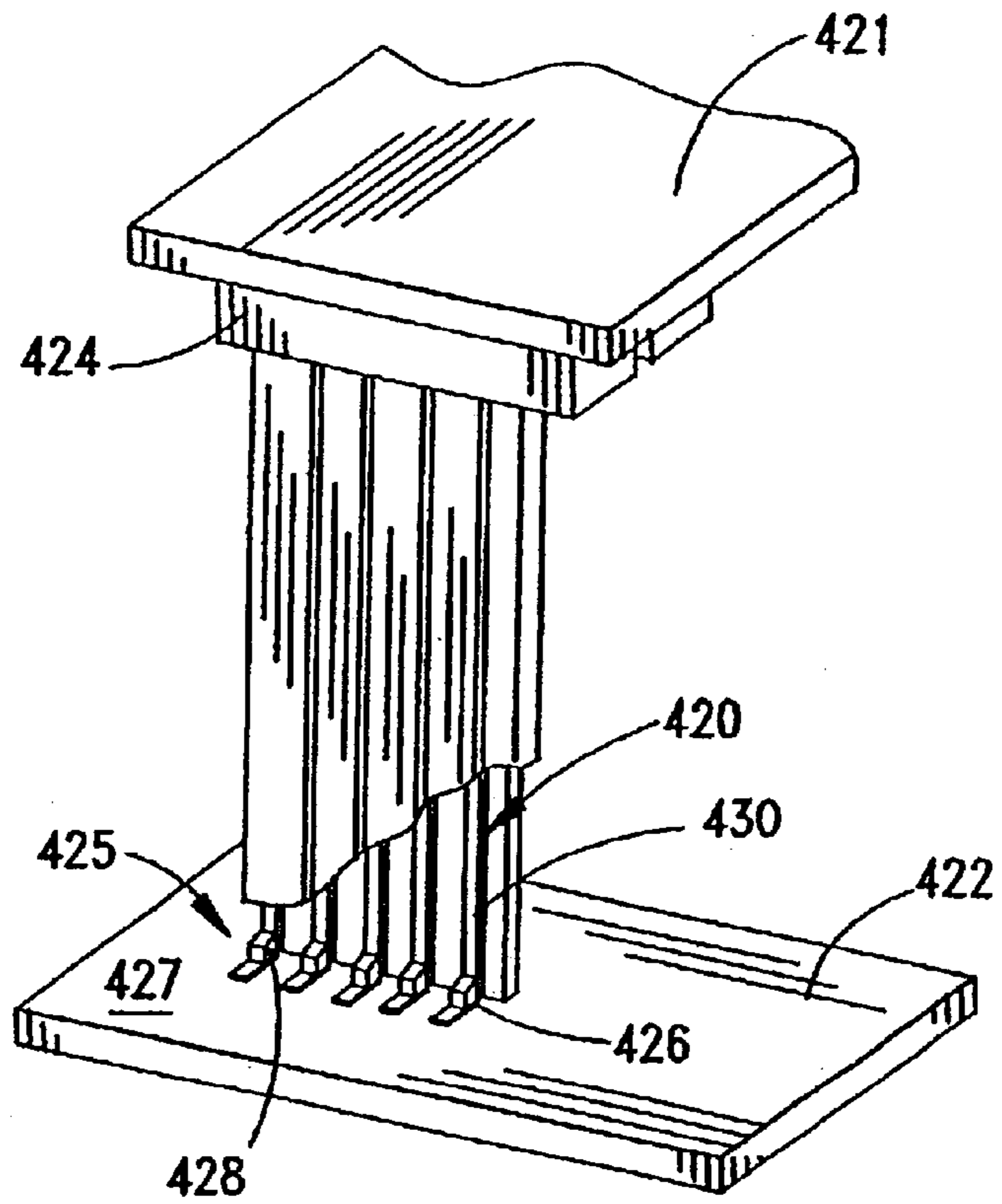


FIG. 36

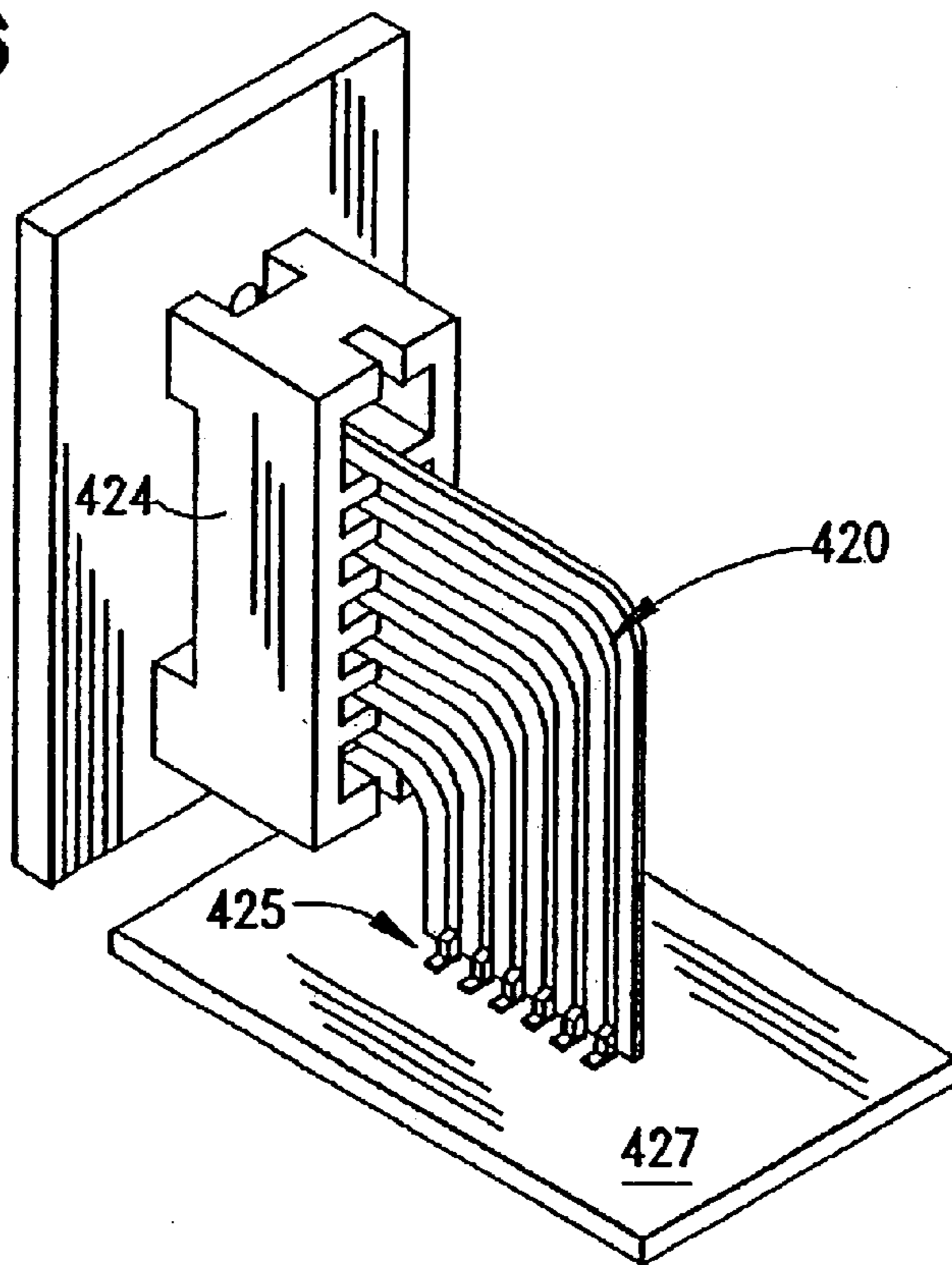


FIG. 37

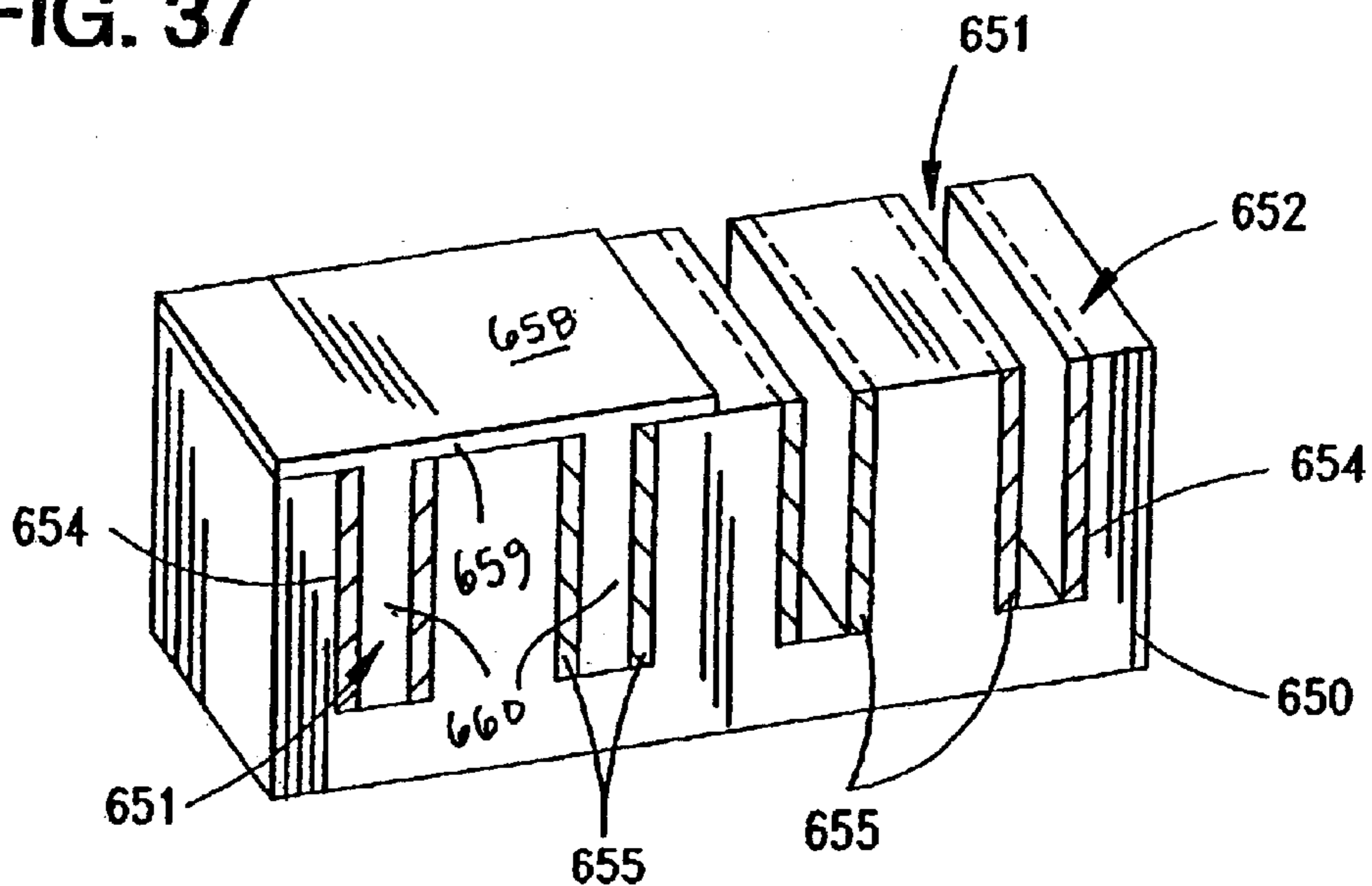


FIG. 38

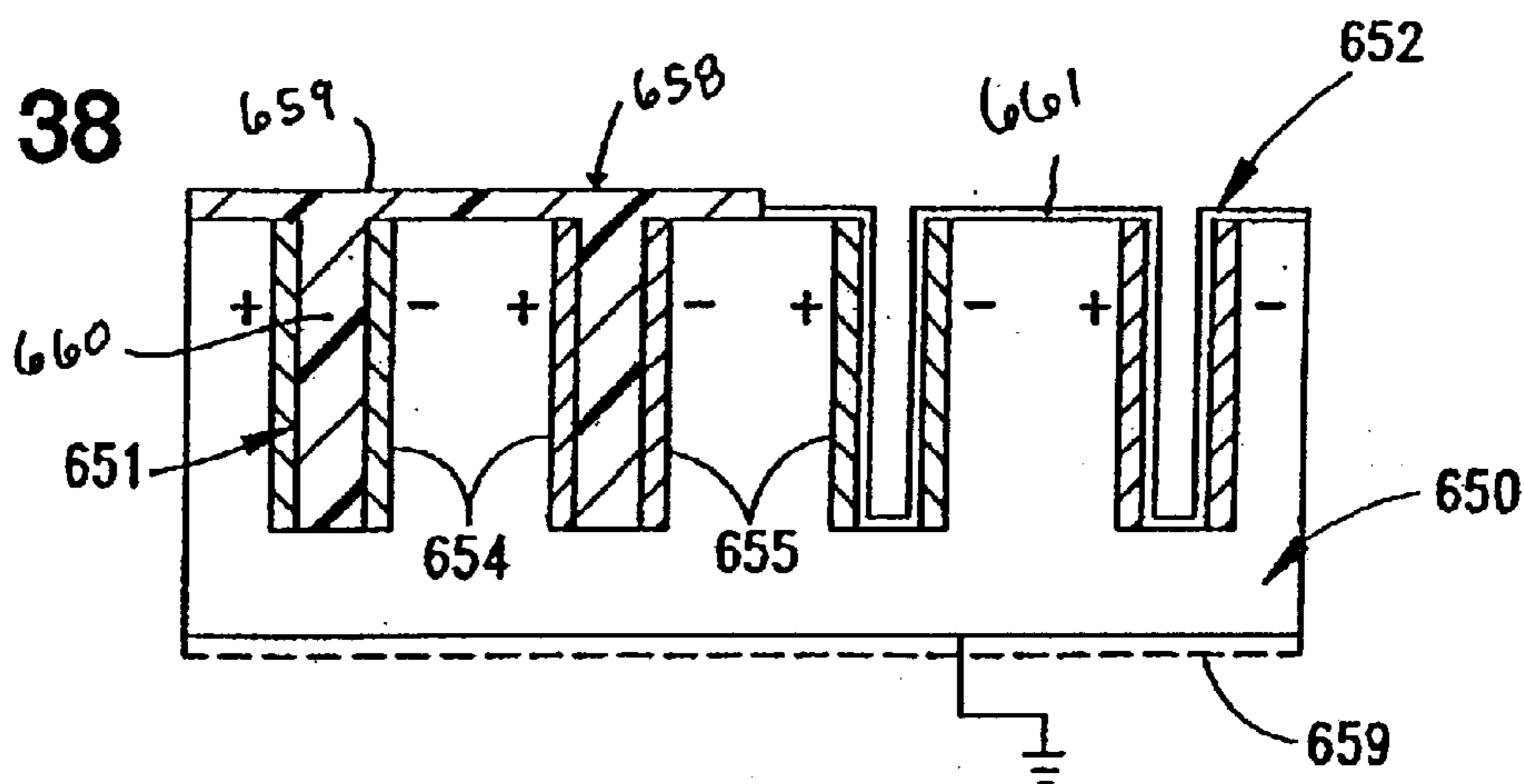


FIG. 39

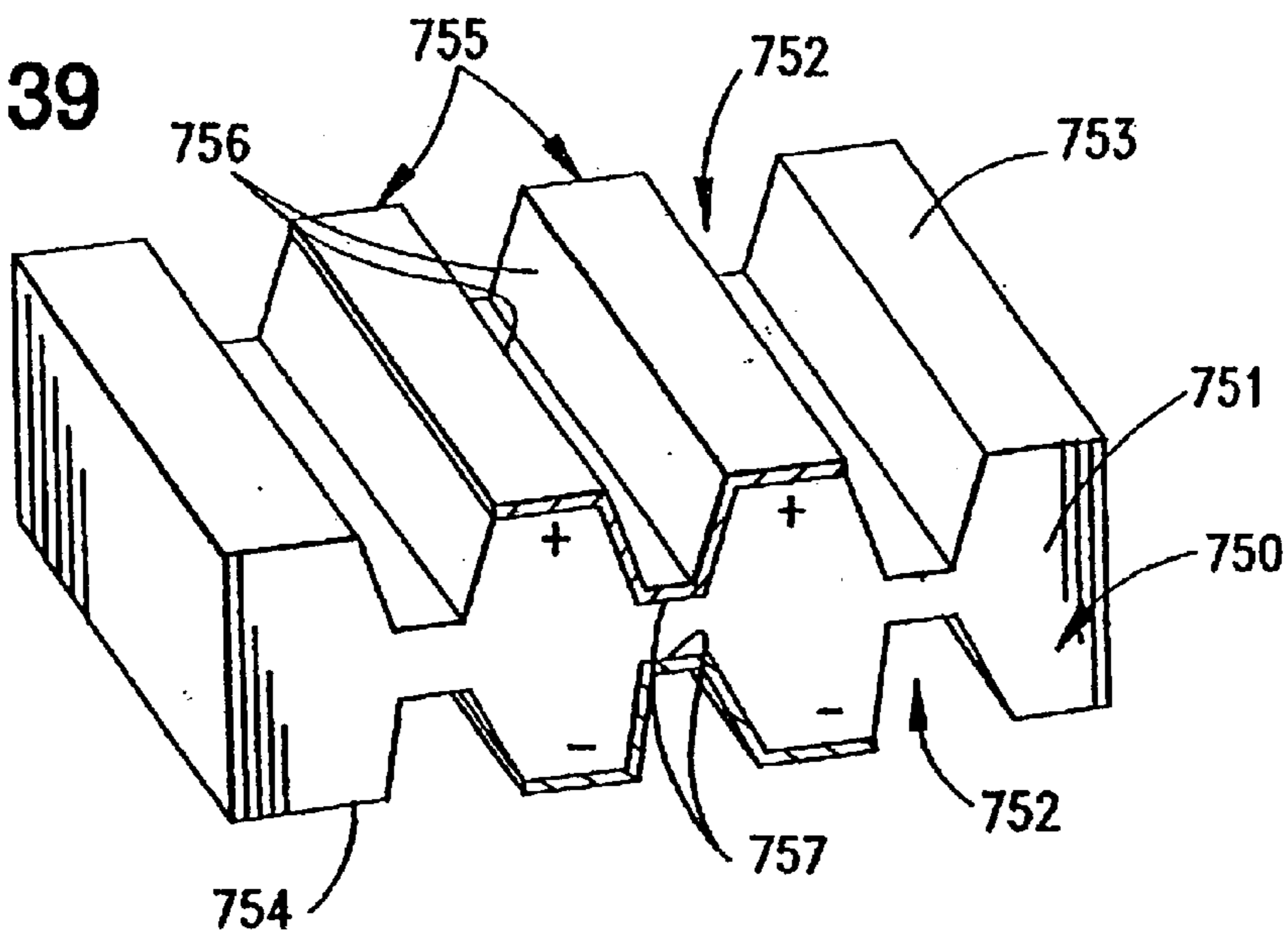


FIG. 41

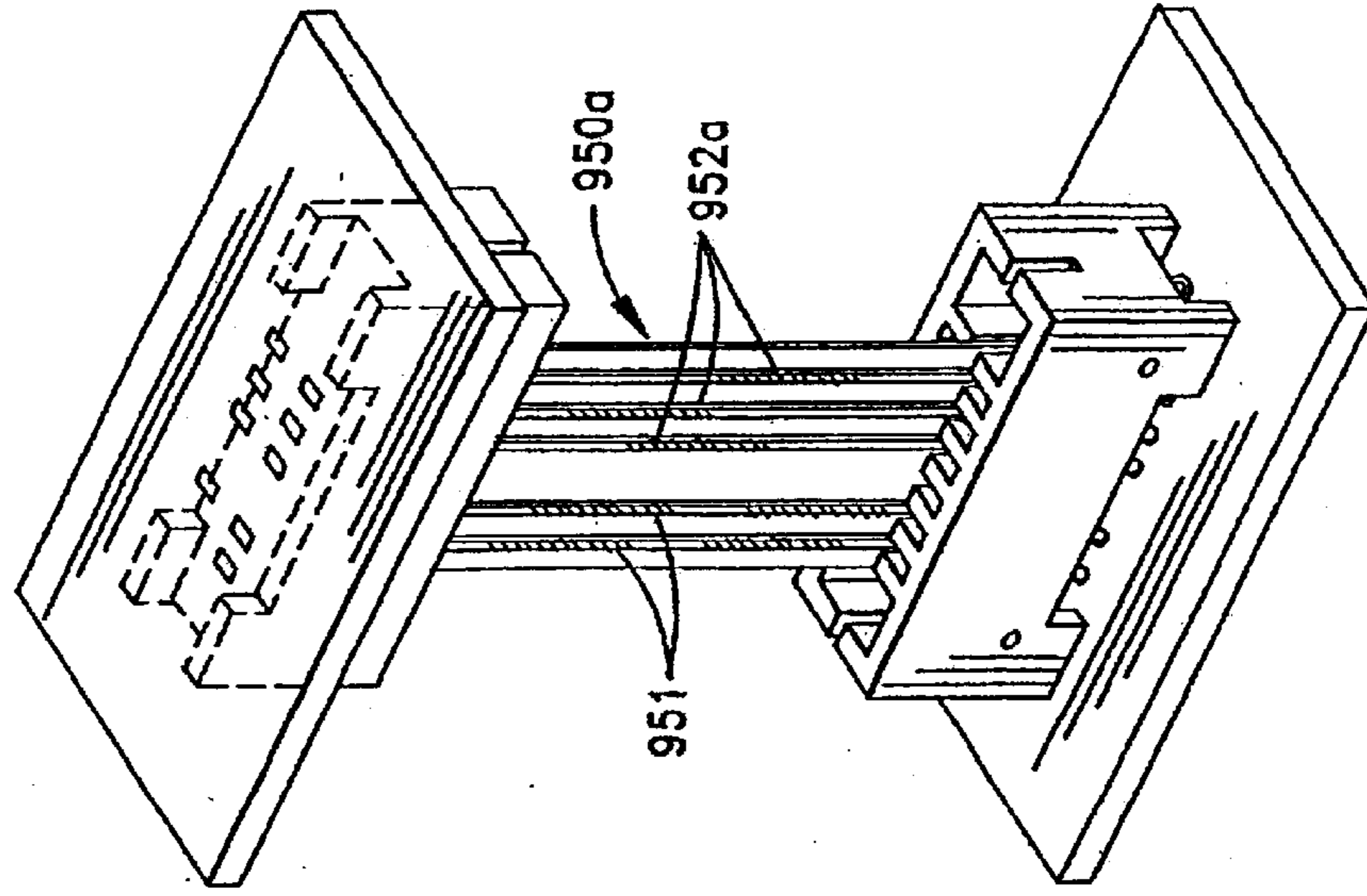
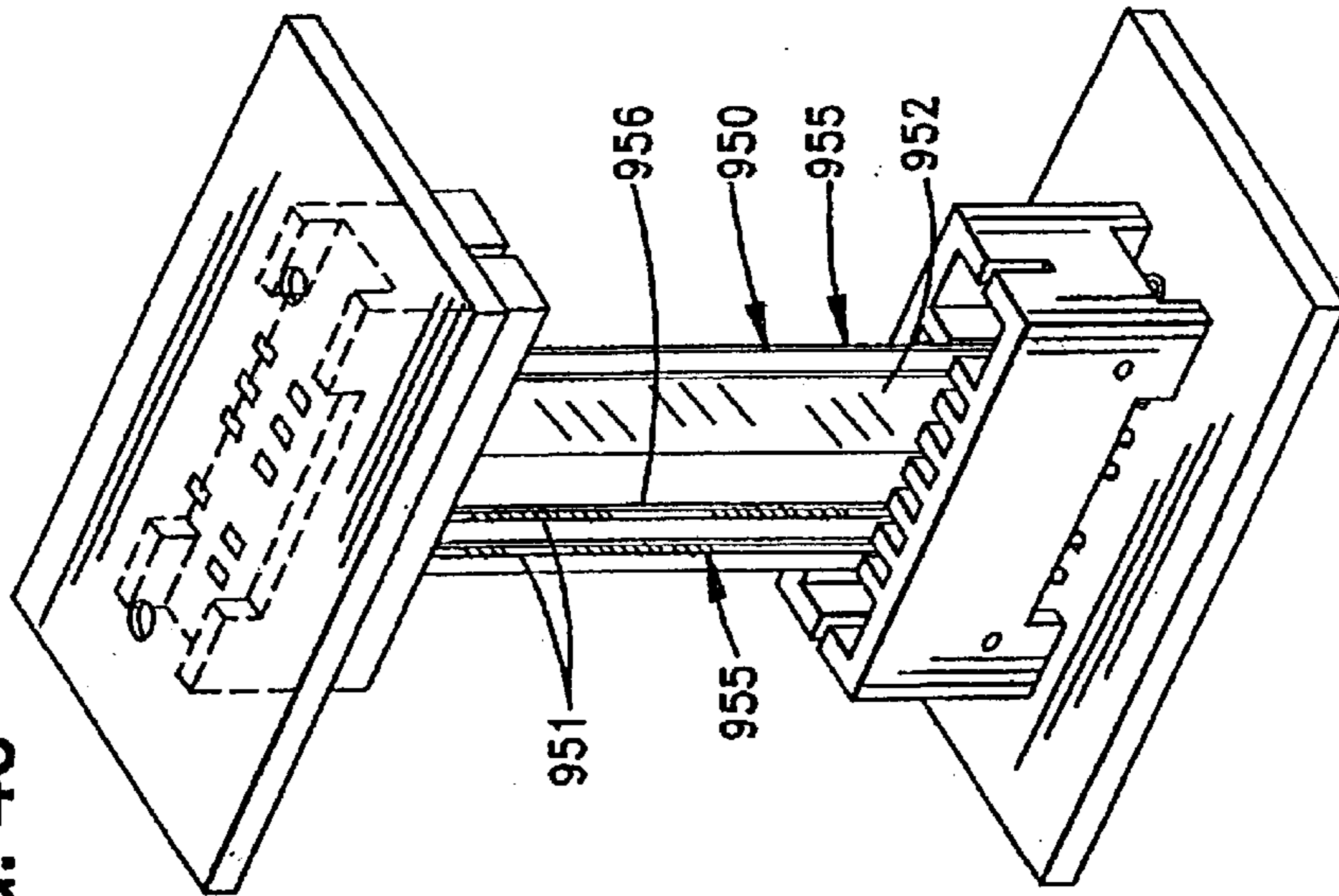


FIG. 40



**GROUPED ELEMENT TRANSMISSION
CHANNEL LINK TERMINATION
ASSEMBLIES**

REFERENCE TO RELATED APPLICATIONS

This application claims priority of prior United States provisional patent applications No. 60/344,223 filed Dec. 28, 2001 and No. 60/354,581, filed Feb. 5, 2002.

BACKGROUND OF THE INVENTION

The present invention pertains to multi-circuit electronic communication systems, and more particularly, to a dedicated transmission channel structure for use in such systems.

Various means of electronic transmission are known in the art. Most, if not all of these transmission means, suffer from inherent speed limitations such as both the upper frequency limit and the actual time a signal requires to move from one point to another within the system, which is commonly referred to as propagation delay. They simply are limited in their electronic performance primarily by their structure, and secondarily by their material composition. One traditional approach utilizes conductive pins, such as those found in an edge card connector as is illustrated in FIG. 1. In this type of structure a plurality of conductive pins, or terminals **20**, are arranged within a plastic housing **21** and this arrangement provides operational speeds of about 800 to 900 MHz. An improvement upon this standard structure is represented by edge card connectors that may be known in the art as "Hi-Spec" and which are illustrated in FIG. 2, in which the system includes large ground contacts **25** and small signal contacts **26** disposed within an insulative connector housing **27**. The smaller signal contacts **26** couple to the larger ground contacts **25**. The signal contacts in these structures are not differential signal contacts, but are merely single-ended signal, meaning that every signal contact is flanked by a ground contact. The operational speeds for this type of system are believed to be about 2.3 Ghz.

Yet another improvement in this field is referred to as a "triad" or "triple" connector in which conductive terminals are disposed within a plastic housing **28** in a triangular pattern, and the terminals include a large ground terminal **29**, and two smaller differential signal terminals **30**, as illustrated in FIG. 3, and, as described in greater detail U.S. Pat. No. 6,280,209. This triad/triple structure has an apparent upper limit speed of about 4 Ghz. All three of these approaches utilize, in the most simplest sense, conductive pins in a plastic housing in order to provide a transmission line for electronic signals.

In each of these type constructions, it is desired to maintain a dedicated transmission line through the entire delivery path of the system, including through the circuit board(s), the mating interface and the source and load of the system. It is difficult to achieve the desired uniformity within the system when the transmission system is constructed from individual pins. Discrete point-to-point connections are used in these connectors for signal, ground and power. Each of these conductors was designed as either a conductor or a means of providing electrical continuity and usually did not take into account transmission line effects. Most of the conductors were designed as a standard pinfield so that all the pins, or terminals, were identical, regardless of their designated electrical function and the pins were further arranged at a standard pitch, material type and length. Although satisfactory in performance at low operating speeds, at high operational speeds, these systems would consider the conductors as discontinuities in the system that affect the operation and speed thereof.

Many signal terminals or pins in these systems were commoned to the same ground return conductor, and thus created a high signal to ground ratio, which did not lend themselves to high-speed signal transmission because large current loops are forced between the signals and the ground, which current loops reduce the bandwidth and increase the crosstalk of the system, thereby possibly degrading the system performance.

Bandwidth ("BW") is proportional to $1/\sqrt{LC}$, where L is the inductance of the system components, C is the capacitance of the system components and BW is the bandwidth. The inductive and capacitive components of the signal delivery system work to reduce the bandwidth of the system, even in totally homogeneous systems without discontinuities. These inductive and capacitive components can be minimized by reducing the overall path length through the system, primarily through limiting the area of the current path through the system and reducing the total plate area of the system elements. However, as the transmission frequency increases, the reduction in size creates its own problem in that the effective physical length is reduced to rather small sizes. High frequencies in the 10 Ghz range and above render most of the calculated system path lengths unacceptable.

In addition to aggregate inductance and capacitance across the system being limiting performance factors, any non-homogeneous geometrical and/or material transitions create discontinuities. Using about 3.5 Ghz as a minimum cutoff frequency in a low voltage differential signal system operating at around 12.5 Gigabits per second (Gbps), the use of a dielectric with a dielectric constant of about 3.8 will yield a critical path length of about 0.25 inches, over which length discontinuities may be tolerated. This dimension renders impracticable the ability of one to construct a system that includes a source, transmission load and load within the given quarter-inch. It can thus be seen that the evolution of electronic transmission structures have progressed from uniform-structured pin arrangements to functionally dedicated pins arrangements to attempted unitary structured interfaces, yet the path length and other factors still limit these structures. With the aforementioned prior art structures, it was not feasible to carry high frequency signals due to the physical restraints of these systems and the short critical path lengths needed for such transmission.

In order to obtain an effective structure, one must maintain a constant and dedicated transmission line over the entire delivery path: from the source, through the interface and to the load. This would include the matable interconnects and printed circuit boards. This is very difficult to achieve when the delivery system is constructed from individual, conductive pins designed to interconnect with other individual conductive pins because of potential required changes in the size, shape and position of the pins/terminals with respect to each other. For example, in a right angle connector, the relationship between the rows of pins/terminals change in both the length and the electrical coupling. High speed interconnect design principles that include all areas between the source and load of the system including printed circuit boards, board connectors and cable assemblies are being used in transmission systems with sources of up to 2.5 Gbps. One such principle is the principle of ground by design which provides added performance over a standard pin field in that coupling is enhanced between the signal and ground paths and single-ended operation is complimented. Another principle being used in such systems includes impedance tuning to minimize discontinuities. Yet another design principle is pinout optimization where signal

and return paths are assigned to specific pins in the pin field to maximize the performance. These type of systems all are limited with respect to attaining the critical path lengths mentioned above.

The present invention is directed to an improved transmission or delivery system that overcomes the aforementioned disadvantages and which operates at higher speeds.

SUMMARY OF THE INVENTION

The present directed is therefore directed to an improved transmission structure that overcomes the aforementioned disadvantages and utilizes grouped electrically conductive elements to form a unitary mechanical structure that provides a complete electronic transmission channel that is similar in one sense to a fiber optic system. The focus of the invention is on providing a complete, copper-based electronic transmission channel rather than utilizing either individual conductive pins or separable interfaces with copper conductors as the transmission channel, the transmission channels of the invention yielding more predictable electrical performance and greater control of operational characteristics. Such improved systems of the present invention are believed to offer operating speeds for digital signal transmission of up to at least 12.5 GHz at extended path lengths which are much greater than 0.25 inch.

Accordingly, it is a general object of the present invention to provide an engineered waveguide that functions as a grouped element channel link, where the link includes an elongated dielectric body portion and at least two conductive elements disposed along the exterior surface thereof.

Another object of the present invention is to provide a high-speed channel link (or transmission line) having an elongated body portion of a given cross-section, the body portion being formed from a dielectric with a selected dielectric constant, and the link having, in its most basic structure, two conductive elements disposed on the exterior surface thereof, the elements being of similar size and shape and oriented thereon, in opposition to each other, so as to steer the electrical energy wave traveling through the link by establishing particular electrical and magnetic fields between the two conductive elements and maintaining these fields throughout the length of the channel link.

A further object of the present invention is to control the impedance of the channel link by selectively sizing the conductive elements and the gaps therebetween on the exterior surface of the elongated body to maintain balanced or unbalanced electrical & magnetic fields.

Yet another object of the present invention is to provide a improved electrical transmission channel that includes a flat substrate, and a plurality of grooves formed in the substrate, the grooves having opposing sidewalls and the grooves being spaced apart by intervening lands of the substrate, the sidewalls of the grooves having a conductive material deposited thereon, such as by plating or deposition, to form electronic transmission channels within the grooves.

A still further object of the present invention is to provide a pre-engineered wave guide in which at least a pair of conductive elements are utilized to provide differential signal transmission, i.e., signal in (“+”) and signal out (“-”), the pair of conductive elements being disposed on the exterior of the dielectric body so as to permit the establishment of capacitance per unit length, inductance per unit length, impedance, attenuation and propagation delay per unit length, and establishing these pre-determined performance parameters within the channels formed by the conductive elements.

A yet further object of the present invention is to provide an improved transmission line in the form of a solid link, of preferably uniform, circular cross-section, the link including at least a pair of conductive elements disposed thereon that serve to guide the electrical wave therethrough, the link including at least one thin filament of dielectric material having two conductive surfaces disposed thereon, the conductive surfaces extending lengthwise of the filament and separated by two circumferential arcuate extents, the conductive surfaces further being separated from each other to form a discrete, two-element transmission channel that reduces the current loop and in which the signal conductors are more tightly aligned.

Yet another object of the present invention is to provide a non-circular transmission line for high speed applications, which includes an elongated rectangular or square dielectric member having an exterior surface with at least four distinct sectors disposed thereon, the dielectric member including a pair of conductive elements aligned with each other and disposed on two of the sectors, while separated by an intervening sector.

The present invention accomplishes the above and other objects by virtue of its unique structure. In one principal aspect, the present invention includes a transmission line that is formed from a dielectric with a preselected dielectric constant and a preselected cross-sectional configuration. A pair of conductive surfaces are disposed on the dielectric line, or link, and one preferably aligned with each other and separated from each other. The conductive surfaces serve as wave guides for guiding electrical waves along the transmission link.

In another principal aspect of the present invention, the conductive elements are grouped together as a pair on a single element, thus defining a unitized wave guide that may be run between and among successive printed circuit boards and connected thereto without difficulty. The conductive surfaces may be formed by selectively depositing conductive material thereon, such as by plating, the exterior surface of the dielectric body, or by molding or otherwise attaching an actual conductor to the body. In this manner, the dielectric may be formed with bends and the conductive surfaces that exist on the surface thereof maintains their spaced apart arrangement of grouped channel conductors along and throughout the bends of the dielectric body.

In yet another principal aspect of the invention, the exterior of the transmission line may be covered by a protective outer jacket, or sleeve. The conductive surfaces may be disposed on the dielectric body in a balanced arrangement with equal widths, or an unbalanced arrangement with one or more pairs of conductive elements, and the conductive elements having different widths. Three conductive elements may be disposed on the dielectric body to support a differential triple on the transmission line utilizing a pair of differential signal conductors and an associated ground conductor. The number of conductive surfaces is limited only by the size of the dielectric body, and four such discrete conductive elements may be used to support two different signal channels or a single differential pair with dual grounds.

In still another principal aspect of the present invention, a unitary transmission line is formed within one cavity, or within a plurality of selectively-sized metallized cavities are formed within a substrate. The substrate is grooved to form the cavities and the sidewalls of the grooves may be plated with a conductive material. The air gap between the sidewalls of the cavities, or grooves, in this instance, serves as

the dielectric of the transmission channel. In this structure, the dielectric constant of air is different and less than the dielectric constant of the dielectric body so as to influence electrical affinity, and particularly coupling between the conductive elements in the grooves and not between adjacent signal transmission channels of the transmission line, while increasing transmission speed.

In yet another principal aspect of the present invention, the aforementioned transmission links may be used to carry power. In such circumstances, the underlying transmission line will include a grooved dielectric, with a continuous contact region being formed within the grooves, i.e., covering the sidewalls and bases of the groove. The continuous contact area that is present on these three surfaces for the length of the groove extends the current carrying capability of the structure. A ground plane may be utilized to increase capacitive coupling among the power channels and the ground plane to reduce the source impedance of the overall structure. The transmission line may be formed with projecting ridges, or lands, that serve to define troughs therebetween. The conductive surfaces are formed in the troughs by way of a continuous process, such as selective plating, so that a continuous plated trough, i.e., two sidewalls and an interconnecting base are formed which extend for the length of the transmission line. This increases the current carrying capability of the transmission line. A high capacitance may then be created across the dielectric between two signal conductors to reduce the source impedance of the system.

The power carrying aspect of the invention may be further supplemented by the forming of high density contact sets within the system. In a grooved transmission line the opposing sidewalls of the grooves may be plated with a conductive material to form continuous contacts that extend the length of the transmission line and opposite polarity signals (i.e., "+" and "-") may be carried along these contacts. A plug assembly may be molded, such as by way of insert molding into the grooves, either individually or as an assembly encompassing two or more such grooves to insulate and isolate the opposed contact pairs, which will result in an increased voltage standoff. A conformal coating may also be used to achieve a similar aim.

The transmission lines of the invention may carry both signals and power and thus may be easily divided into separate signal channels and power channels. The signal channels may be made with conductive strips or paths of a preselected width, while the power channels, in order to carry high currents, may include either wider strips or an enlarged, continuous conductor strip. The wider strips are enlarged plate areas as compared to the signal strips and have a high capacitance. The signal and power channels may be separated by a wide, non-conductive area of the transmission line that serves as an isolation region. Because the isolation region may be formed during the forming of the underlying dielectric base, the isolation region may be readily defined to minimize cross-contamination or electrical interference.

These and other objects, features and advantages of the present invention will be clearly understood through a consideration of the following detailed description.

BRIEF DESCRIPTION OF THE DRAWINGS

In the course of this detailed description, the reference will be frequently made to the attached drawings in which:

FIG. 1 is a schematic plan view of the terminating face of a conventional connector;

FIG. 2 is a schematic plan view of an edge card used in a high speed connector;

FIG. 3 is a schematic elevational view of a high speed connector utilizing a triad or triple;

FIG. 4 is a perspective view of a grouped element channel link constructed in accordance with the principles of the present invention.

FIG. 5 is a schematic end view of the grouped element channel link of FIG. 4 illustrating the arcuate extents of the conductive elements and the spacing therebetween;

FIG. 6 is a perspective view of an alternate embodiment of a grouped element channel link constructed in accordance with the principles of the present invention.

FIG. 7 is a schematic view of a transmission link of the present invention used to connect a source with a load having intermediate loads on the transmission link;

FIG. 8 is a schematic view of a connector element utilizing both conventional contacts "A" and the transmission links "B" of the invention, with enlarged detail portions at "A" and "B" thereof, illustrating the occurrence of inductance in the respective systems;

FIG. 9 is a perspective view of an alternate construction of a link of the invention with a right angle bend formed therein;

FIG. 10 is a schematic view of a transmission line utilizing the links of the present invention;

FIG. 11 is a perspective view illustrating alternate media compositions of the links of the invention;

FIG. 12 is a perspective view of an array of different shapes of dielectric bodies illustrating alternate conductive surface arrangements;

FIG. 13 is a perspective view of an array of non-circular cross-section dielectric bodies that may be used to form links of the invention;

FIG. 14 is a perspective view of another array of non-circular cross-section dielectric bodies suitable for use as links of the invention;

FIG. 15 is an exploded view of a connector assembly incorporating a multiple element link of the invention that is used to provide a transmission line between two connectors;

FIG. 16 is a perspective view of a connector assembly having two connector housings interconnected by the transmission link of FIG. 15;

FIG. 17 is a diagrammatic view of a transmission channel of the present invention with two interconnecting blocks formed at opposite ends of the channel and illustrating the potential flexible nature of the invention;

FIG. 18 is a perspective view of an array of differently configured dielectric bodies that may be used as links of the with different lens characteristics;

FIG. 19 is a perspective view of a multiple transmission link extrusion with different signal channels formed thereon;

FIG. 20 is a perspective view of a multiple transmission link extrusion used in the invention;

FIG. 21 is a perspective view of a mating interface used with a discrete transmission link of the invention, in which mating interface takes the form of a hollow endcap;

FIG. 22 is a rear perspective view of the endcap of FIG. 21, illustrating the center opening thereof that receives an end portion of the transmission link therein;

FIG. 23 is a frontal perspective view of the endcap of FIG. 21, illustrating the orientation of the exterior contacts;

FIG. 24 is a plan view of a multiple transmission link right angle, curved connector assembly;

FIG. 25 is a perspective view of an alternate construction of one of the termination ends of the connector assembly;

FIG. 26 is a perspective view of a connector suitable for use in connecting transmission channel links of the present invention to a circuit board;

FIG. 27A is a skeletal perspective view of the connector of FIG. 26 illustrating, in phantom, some of the internal contacts of the connector;

FIG. 27B is a perspective view of the interior contact assembly of the connector of FIG. 27A, with the sidewalls removed and illustrating the structure and placement of the coupling staple thereon;

FIG. 28 is a cross-sectional view of the connector of FIG. 26, taken along lines 28—28 thereof;

FIGS. 29A-C are end views of other embodiments of transmission channel links that utilize, in FIG. 29A, the dielectric body of the transmission channel for the medium through which coupling is effected, and in FIGS. 29B-C, the air spacing between the conductive elements as the medium through which coupling is effected;

FIG. 30 is an end view of an array of transmission channel links of FIG. 29C arranged on a mount and illustrating the packing of transmission channels that may be obtained with the present invention;

FIG. 31 is a plan view illustrating a right angle configuration of an air dielectric transmission channel similar to those of FIGS. 29A-C;

FIG. 32 is a perspective view of a waveguide assembly constructed in accordance with the principles of the present invention;

FIG. 33 is a sectional view of the waveguide assembly of FIG. 32, taken along lines 33—33 thereof;

FIG. 34 is an enlarged detail view of a sectional view of the waveguide assembly of FIG. 32, taken along lines 34—34 thereof;

FIG. 35 is a perspective view of a connector assembly using a grouped channel transmission element of the invention extending between two circuit boards and protected by an exterior, protective jacket;

FIG. 36 is a perspective view of a variation in the use of the grouped element channel links of the invention, illustrating a right angle application thereof used to connect two circuit boards together;

FIG. 37 is a perspective view of a high-voltage, high-density transmission line constructed in accordance with the principles of the present invention;

FIG. 38 is an end view of the transmission line of FIG. 37;

FIG. 39 is a perspective view of a transmission line of the invention that is suitable for use as a low impedance power transmission line;

FIG. 40 is a perspective view of a mixed signal and power transmission line of the invention extending between two connectors and wherein the signal and power conductors are separated by a single isolation region; and,

FIG. 41 is a perspective view of another mixed signal and power transmission line extending between two connectors and having multiple isolation regions disposed thereon to separate the signal and power conductors from each other electrically.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

FIG. 4 illustrates a grouped element channel link 50 constructed in accordance with the principles of the present invention. It can be seen that the link 50 includes an elongated, dielectric body 51, preferably a cylindrical

filament, that is similar to a length of fiber optic material. It differs therefrom in that the link 50 acts as a pre-engineered wave guide and a dedicated transmission media. In this regard, the body 51 is formed of a dedicated dielectric having a specific dielectric constant and a plurality of conductive elements 52 applied thereto. In FIGS. 4 and 5, the conductive elements 52 are illustrated as elongated extents, traces or strips, 52 of conductive material and, as such, they may be traditional copper or precious metal extents having a definite cross-section that may be molded or otherwise attached, such as by adhesive or other means to the dielectric body of the link 50. They may also be formed on the exterior surface 55 of the body 51 such as by a suitable plating or vacuum deposition process. The conductive traces 52 are disposed on the exterior surface and have a width that extends along the perimeter of the dielectric body.

At least two such conductors are used on each link, typically are used for signal conveyance of differential signals, such as +0.5 volts and -0.5 volts. The use of such a differential signal arrangement permits us to characterize structures of this invention as pre-engineered waveguides that are maintained over substantially the entire length of the signal delivery path. The use of the dielectric body 51 provides for preferred coupling to occur within the link. In the simplest embodiment, as illustrated in FIG. 5, the conductive elements are disposed on two opposing faces, so that the electrical affinity of each of the conductive elements is for each other through the dielectric body upon which they are supported, or in the case of a conductive channel as will be explained in greater detail to follow and as illustrated in FIGS. 29-30, the conductive elements are disposed on two or more interior faces of the cavity/cavities to establish the primary coupling mode across the cavity gap and through an air dielectric. In this manner, the links of the present invention may be considered as the electrical equivalent to a fiber optic channel or extent.

The present invention is directed to electrical waveguides, and not either optical or microwave waveguides. The waveguides of the present invention are intended to maintain electrical signals at desired levels of electrical affinity at high frequencies from about 1.0 Ghz to at least 12.5 Ghz and preferably higher. Optical waveguides, as described in U.S. Pat. No. 6,377,741, issued Apr. 23, 2002, typically rely upon a single outer coating, or cladding, having mirror-like reflective properties to maintain the light particles moving in a selected direction. Openings in the outer coating/cladding will result in a dispersal of the light traveling through the waveguide, which adversely affects the light beam of the waveguide. Microwave waveguides are used at very high frequencies to direct the energy of the microwave beam, rather than transmit it as exemplified by U.S. Pat. No. 6,114,677, issued Sep. 5, 2002 in which a microwave waveguide is used to direct the microwaves at the center portion of an oven. Such a directional aim is also utilized the microwave antenna art. In each instance, these type of waveguides are used to focus and direct the energy of the light of microwave traveling through them, whereas in the present invention, the entire waveguide structure is engineered to maintain an electrical signal at desired frequency (ies) and impedance, capacitance and inductance.

The effectiveness of the links of the present invention are dependent upon the guiding and maintenance of digital signals through the channel link, by utilizing two or more conductive surfaces of electrical containment. This will include maintaining the integrity of the signal, controlling the emissions and minimizing loss through the link. The

channel links of the present invention contain the electromagnetic fields of the signals transmitted therethrough by controlling the material of the channel link and the geometries of the system components so that preferred field coupling will be provided. Simply stated, the present invention creates an engineered transmission line by defining a region of electrical affinity, i.e., the dielectric body **51**, that is bounded by conductors, i.e., conductive surfaces **52**, of opposing charge, i.e., negative and positive differential signals.

As illustrated better in FIG. **5**, the two conductive surfaces **52** are arranged on the dielectric body **51** in opposition to each other. The dielectric body **51** shown in FIG. **4** takes the form of a cylindrical rod, while the dielectric body shown in FIG. **5** has an oval-like configuration. In each such instance, the conductive surfaces or traces **52**, extend for distinct arc lengths. Both FIGS. **4** and **5** are representative of a “balanced” link of the invention where the circumferential extent, or arc length C of the two conductive surfaces **52** is the same, and the circumferential extents or arc lengths $C1$ of the non-conductive exterior surfaces **55** of the dielectric body **51** are also the same. This length may be considered to define a gross separation D between the conductive surfaces. As will be explained below, the link may be “unbalanced” with one of the conductive surfaces having an arc length that is greater than the other, and in such an instance, the transmission line is best suited for single-ended, or non-differential signal applications. In instances where the dielectric body and link are circular, the link may serve as a contact pin and so be utilized in connector applications. This circular cross-section demonstrates the same type of construction as a conventional round contact pin.

As illustrated in FIG. **6**, the links of the present invention may be modified to provide not only multiple conductive elements as part of the overall system transmission media, but may also incorporate a coincident and coaxial fiber optic wave guide therewithin for the transmission of light and optical signals. In this regard, the dielectric body **51** is cored to create a central opening **57** through which an optical fiber **58** extends. Electrical signals may be transmitted through this link as well as light signals **60**.

FIG. **7** schematically illustrates a transmission line **70** incorporating a link **50** of the present invention that extends between a source **71** and a load **72**. The conductive surfaces **52** of the link serve to interconnect the source and load together, as well as other secondary loads **73** intermediate the source and the load. Such secondary loads may be added to the system to control the impedance through the system. A line impedance is established at the source and may be modified by adding secondary loads to the transmission line.

FIG. **8** illustrates, schematically, the difference between the links of the present invention and conventional conductors, which are both illustrated as supported by a dielectric block **76**. Two discrete, conventional conductors **77** are formed from copper or another conductive material and extend through the block **76**, in the manner of pins. As shown in enlargement “A”, the two discrete conductor presents an open cell structure with a large inductance (L) because of the enlarged current loop. Quite differently, the links of the present invention have a smaller inductance (L) at a constant impedance due to the proximity of the conductive surfaces to each other as positioned as the dielectric body **51**. The dimensions of these links **50** can be controlled in the manufacturing process and extrusion will be the preferred process of manufacturing with the conductive surfaces being extended with the dielectric body or separately applied of the extrusion, such as by a selective plating

process so that the resulting construction is of the plated plastic variety. The volume of the dielectric body **51** and the spacing between conductive elements disposed thereon may be easily controlled such an extrusion process. The conductive surfaces preferably extend for the length of the dielectric body and may end slightly before the ends thereof at a location where it is desired to terminate the transmission line to a connector, circuit board or similar component,

As FIG. **9** illustrates, the dielectric body may have a bend **80** forward therewith in the form of the 90° right-angle bend illustrated or in any other angular orientation. As shown, the conductive surfaces **52** extend through the bend **80** with the same separation spacing between them and the same width with which the conductive surfaces start and end. The dielectric body **51** and the conductive surfaces **52** are easily maintained in their spacing and separation through the bend to eliminate any potential losses

FIG. **10** illustrates a transmission line using the links of the invention. The link **50** is considered as a transmission cable formed from one or more single dielectric bodies **51**, and one end **82** of it is terminated to a printed circuit board **83**. This termination may be direct in order to minimize any discontinuity at the circuit board. A short transfer link **84** that maintains any discontinuities at a minimum is also provided. These links **84** maintain the grouped aspect of the transmission link. Termination interfaces **85** may be provided where the link is terminated to the connector with minimum geometry discontinuity or impedance discontinuity. In this manner, the grouping of the conductive surfaces is maintained over the length of the transmission line resulting in both geometric and electrical uniformity.

FIG. **11** illustrates a variety of different cross-sections of the transmission links **50** of the invention. In the rightmost link **90**, a central conductor **93** is encircled by a hollow dielectric body **94** which in turn, supports multiple conductive surfaces **95** that are separated by an intervening space, preferably filled with portions of the dielectric body **94**. This construction is suitable for use in power applications where power is carried by the central conductor **93**. In the middle link **91** of FIG. **11**, the central cover **96** is preferably made of a selected dielectric and has conductive surfaces **97** supported on it. A protective outer insulative jacket **98** is preferably provided to protect and or insulate the inner link. The leftmost link **92** of FIG. **11** has a protective outer jacket **99** that encloses a plateable polymeric ring **100** that encircles either a conductive or insulative core **101**. Portions **101** of the ring **100** are plated with a conductive material and are separated by unplated portions to define the two or more conductive surfaces desired on the body of the ring. Alternatively, one or the elements surrounding the core or of the link **92** may be filled with air and may be spaced away from an inner member by way of suitable standoffs or the like.

FIG. **12** illustrates an array of links **110–113** that have their outer regions combined with the dielectric body **51** to form different types of transmission links. Link **110** has two conductive surfaces **52a**, **52b** of different arc lengths (i.e., unbalanced) disposed on the outer surface of the dielectric body **51** so that the link **110** may provide single-ended signal operation. Link **111** has two equal-spaced and sized (or “balanced”) conductive elements **52** to provide an effective differential signal operation.

Link **112** has three conductive surfaces **115** to support two differential signal conductors **115a** and an assorted ground conductor **115b**. Link **113** has four conductive surfaces **116** disposed on its dielectric body **51** in which the conductive

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surfaces **116** may either include two differential signal channels (or pairs) or a single differential pair with a pair of associated grounds.

FIG. **13** illustrates an array of one-type of non-circular links **120–122** that polygonal configurations, such as square configurations, as with link **120** or rectangular configurations as with links **121–122**. The dielectric bodies **51** may be extruded with projecting land portions **125** that are plated or otherwise covered with conductive material. Individual conductive surfaces are disposed on individual sides of the dielectric body and preferably differential signal pairs of the conductive surfaces are arranged on opposing sides of the body. These land portions **125** may be used to “key” into connector slots of terminating connectors in a manner so that contact between the connector terminals (not shown) and the conductive faces **125** is easily effected.

FIG. **14** illustrates some additional dielectric bodies that may be utilized with the present invention. One body **130** is shown as convex, while the other two bodies **131, 132** are shown as being generally concave in configuration. A circular cross-section of the dielectric bodies has a tendency to concentrate the electrical field strength at the corners of the conductive surfaces, while a slightly convex form as shown in body **130**, has a tendency to concentrate the field strength evenly, resulting in lower attenuation. The concave bodies, as illustrated by dielectric bodies **131, 132** may have beneficial crosstalk reduction aspects because it focuses the electrical field inwardly. The width or arc lengths of these conductive surfaces, as shown in FIG. **14** are less than the width or arc lengths of the respective body sides supporting them.

Importantly, the transmission link may be formed as a single extrusion **200** (FIGS. **15-16**) carrying multiple signal channels thereupon, with each such channel including a pair of conductive surface **202–203**. These conductive surfaces **202, 203** are separated from each other by the intervening dielectric body **204** that supports them, as well as web portions **205** that interconnect them together. This extrusion **200** may be used as part of an overall connector assembly **220**, where the extrusion is received into a complementary shaped opening **210** formed in a connector housing **211**. The inner walls of the openings **210** may be selectively plated, or contacts **212** may be inserted into the housing **211** to contact the conductive surfaces and provide, if necessary, surface mount or through hole tail portions.

FIG. **17** illustrates the arrangement of two transmission channels **50** arranged as illustrated and terminated at one end to a connector block **180** and passing through a right angle block **182** that includes a series of right angle passages **183** formed therein which receive the transmission channel links as shown. In arrangements such as that shown in FIG. **17**, it will be understood that the transmission channel links may be fabricated in a continuous manufacturing process, such as by extrusion, and each such channel may be manufactured with intrinsic or integrated conductive elements **52**. In the manufacturing of these elements, the geometry of the transmission channel itself may be controlled, as well as the spacing and positioning of the conductive elements upon the dielectric bodies so that the transmission channels will perform as consistent and unitary electronic waveguides which will support a single channel or “lane” of signal (communication) traffic. Because the dielectric bodies of the transmission channel links may be made rather flexible, the systems of the invention are readily conformable to various pathways over extended lengths without significantly sacrificing the electrical performance of the system. The one connector endblock **180** may maintain the transmission

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channels in a vertical alignment, while the block **182** may maintain the ends of the transmission channel links in a right angle orientation for termination to other components.

FIG. **18** illustrates a set of convex dielectric blocks or bodies **300–302** in which separation distance **L** varies and the curve **305** of the exterior surfaces **306** of the blocks rises among the links **300–302**. In this manner, it should be understood that the shapes of the bodies may be chosen to provide different lens characteristics for focusing the electrical fields developed when the conductive elements are energized.

FIG. **19** illustrates a multiple channel extrusion **400** with a series of dielectric bodies or blocks **401** interconnected by webs **402** in which the conductive surfaces **403** are multiple or complex in nature. As with the construction shown in FIG. **13**, such an extrusion **400** supports multiple signal channels, with each of the channels preferably including a pair of differential signal conductive elements.

FIG. **20** illustrates a standard extrusion **200** such as that shown in FIGS. **15** and **16**.

The links of the present invention may be terminated into connector and other housings. FIGS. **21-23** illustrate one termination interface as a somewhat conical endcap which has a hollow body **501** with a central opening **502**. The body may support a pair of terminals **504** that mate with the conductive surfaces **52** of the dielectric body **51**. The endcap **500** may be inserted into various openings in connector housings or circuit boards and as such, preferably includes a conical insertion end **510**. The endcap **500** may be structured to terminate only a single transmission line as is illustrated in FIGS. **21-23**, or it may be part of a multiple termination interface and terminate multiple distinct transmission lines as illustrated in FIGS. **24** and **25**.

FIG. **24** illustrates the endcaps **500** in place on a series of links **520** that are terminated to an endblock **521** that has surface mount terminals **522** so that the endblock **521** may be attached to a circuit board (not shown). The endcap need not take the conical structure shown in the drawings, but may take other shapes and configurations similar to that shown and described below.

FIG. **25** illustrates an alternate construction of an end block **570**. In this arrangement, the transmission lines, or links **571**, are formed from a dielectric and include a pair of conductive extents **572** formed on their exterior surfaces (with the extents **572** shown only on one side for clarity and their corresponding extents being formed on the surfaces of the links **571** that face into the plane of the paper of FIG. **25**). These conductive extents **572** are connected to traces **573** on a circuit board **574** by way of conductive vias **575** formed on the interior of the circuit board **574**. Such vias may also be constructed within the body of the end block **570**, if desired. The vias **575** are preferably split as shown and their two conductive sections are separated by an intervening gap **576** to maintain separation of the two conductive transmission channels at the level of the board.

FIG. **26** illustrates an endcap, or block **600** mounted to a printed circuit board **601**. This style of endcap **600** serves as a connector and thus includes a housing **602**, with a central slot **603** with various keyways **604** that accept projecting portions of the transmission link. The endcap connector **600** may have a plurality of windows **620** for access to soldering the conductive tail portions **606** of the contacts **607** to corresponding opposing traces on the circuit board **601**. In instances of surface mount tails as shown, the tails **606** may have their horizontal parts **609** tucked under the body of the endcap housing to reduce the circuit board pad size needed, as well as the capacitance of the system at the circuit board.

FIG. 27A illustrates a partial skeletal view of the endcap connector **600** and shows how the contacts, or terminals **607** are supported within and extend through the connector housing **602**. The terminals **607** may include a dual wire contact end **608** for redundancy in contact (and for providing a parallel electrical path) and the connector **600** may include a coupling staple **615** that has an inverted U-shape and which enhances coupling of the terminals across the housing. The coupling staple **615** can be seen to have an elongated backbone that extends lengthwise through the connector housing **602**. A plurality of legs that are spaced apart from each other by spaces along the length of the coupling staple extend down toward the circuit board and each such leg has a width that is greater than a corresponding width of the terminal that it opposes. As shown in the drawings, the coupling staple legs are positioned in alignment with the terminals. The tail portions of these dual wire terminals **607** enhance the stability of the connector. In this regard, it also provides control for the terminals that constitute a channel (laterally) across the housing slot **601**. The dual contact path not only provides for path redundancy but also reduces the inductance of the system through the terminals. FIG. 27B is a view of the interior contact assembly that is used in the endcap connector **600** of FIGS. 26 and 27A. The terminals **607** are arranged on opposite sides of the connector and are mounted within respective support blocks **610**. These support blocks **610** are spaced apart from each other a preselected distance that assists in spacing the terminal contacts **608** apart.

A conductive coupling staple **615** having an overall U-shape, or blade shape, may be provided and may be interposed between the terminals **607** and support blocks **610** to enhance the coupling between and among the terminals **607**. The coupling staple **615** has a series of blades **620** that are spaced apart by intervening spaces **621** and which are interposed between pairs of opposing contacts (FIG. 28) **6087** and which extend downwardly toward the surface of the circuit board. The staple **615** extends lengthwise through the connector body between the connector blocks **610**. The connector blocks **610** and the connector housing **602** (particularly the sidewalls thereof) may have openings **616** formed therein that receive engagement plugs **617** therein to hold the two members in registration with each other. Other means of attachment may be utilized, as well.

FIG. 28 is an end view of the connector **600** which illustrates the interposition of the coupling staple between a pair of opposing contacts **608** and the engagement of the connector blocks **610** and the connector housing **602**.

FIGS. 29A-C illustrate another embodiment of a transmission channel link constructed in accordance with the principles of the present invention utilizing air as the dielectric and utilizing broadside coupling between conductive elements. In FIG. 29A, a dielectric substrate **700** is provided of generally uniform cross-section and has enlarged body, or land portions **701**, formed at intervals thereon, with conductive elements **702** disposed on opposite surfaces of the substrate **700**. The body portions **701** are shown interconnected by web portions **703** that have a thickness that is less than the thickness of the body portions **701**. As shown in FIG. 29A, the enlarged body portions **701** are preferably aligned with each other, as are the conductive surfaces supported thereby.

The conductive elements are preferably plated surfaces of the substrate **700**, or a layer formed by a suitable deposition process. In this manner, vertical signal channels are thereby defined in this arrangement, which are identified in the boxes "1-4" appearing below each of the bodies **701** in FIG. 29A. The polarity of the conductive elements **702** may be arranged to provide for differential signal transmission, and as illustrated, one such arrangement locates the positive

("+") signal conductive surfaces on one side and the negative ("-") conductive surfaces on the other, and preferably opposite side of the dielectric substrate. As will be understood in the art, the opposite polarity conductive extents **702** will constitute, pairs or signal channels, shown labeled from "1" to "4" underneath FIG. 29A. In this embodiment, the opposite conductive pairs are separated by the volume and extent of the intervening and supporting dielectric substrate. This construction is suitable for mezzanine configurations and utilizes a structured non-air dielectric.

FIG. 29B illustrates a variation in structure of such a connector with a dielectric body or substrate **700'** having a plurality of slots **705'** formed therein that are spaced apart from each other along the width of the substrate and which uses air as its selected dielectric between the two conductive elements of each signal channel. Conductive surfaces **702'** are disposed on the facing sides (or sidewalls) of the slots and are spaced apart from each by an intervening gap, which is filled with air. In this structure, the polarity of the conductive surfaces may be chosen as shown to have negative and positive signal conductive surfaces facing each other, as shown in FIG. 29B, thereby utilizing the air on the slot **705'** as the dielectric between the associated pairs of conductive surfaces. Whereas in the embodiment of FIG. 29A, the signal pairs or channels were arranged vertically, or through the dielectric body, in the embodiment of FIGS. 29B and 29C, the arrangement and electrical affinity thereof is horizontally and through an intervening air gap. In constructing transmission channels of this sort, the entire exterior surface of the substrate may be plated and the upper exterior surfaces **706'** may be etched to remove their plating. Any plating that is initially present in the base **708'** between the two sidewalls may be removed, such as by etching it away. As a result, a plurality of conductively disassociated vertical plates **702'** are formed. In this type of arrangement, the primary field coupling occurs between oppositely charged pairs of conductive surfaces (horizontally in FIG. 29B), and the air gaps, or spacings, are tighter between the oppositely charged pairs of conductive surfaces than is the spacing between the gaps themselves. Thus, the differential pair spacing is "electrically" tighter by way of geometric control to ensure that the primary electrical affinity remains within the differential pair.

FIG. 29C illustrates a similar structure, but one which utilizes a conductive ground plane **710'** applied to the lower surface of the dielectric substrate **700'**. Such structures may be used to form dense matrices of transmission channel links as is illustrated in FIG. 30 wherein a plurality of substrates **700'** are stacked together on their side. Each substrate may include a ground plane **710'** and three communication or signal lanes, as illustrated or other arrangements may be chosen.

FIG. 31 illustrates the use of such a structure within a right angle context and formed in a dielectric body interior surfaces, rather than exterior surfaces. This is shown as a dielectric block **800** with a plurality of grooves, or cavities **804** formed therein. The opposite walls of the grooves **804** may be plated with conductive surfaces **803** that extend from one end **806** to a bell mouth **802** at the other end **807**. The conductive surfaces **803** are spaced apart from each other and end short of the bell mouths **802** to electrically decouple the channel from the next transmission channel link section.

FIGS. 32-34 illustrate another construction of a waveguide media constructed in accordance with the principles of the present invention. As shown in FIG. 32, a dielectric substrate **900** is provided with a plurality of slots, or grooves **902**, formed thereon. The slots **902** are formed in opposing surfaces of the dielectric substrate **900** and define a series of raised lands that support plated or otherwise conductive surfaces **903**. The slots **902** may be considered as

forming a series of thin webs **904** that reduce the cross-section of the dielectric and reduce capacitive coupling between alternate channels. The width of the conductive surface may be controlled within each signal channel or lane in order to control the impedance of the channels. As shown best in FIG. **34**, surface mount members, such as feet **910** may be formed with the substrate and may include the conductive surfaces disposed on their exterior surfaces in order to establish a conductive interface for connecting with a circuit board, such as by soldering. The substrate **900** is shown formed with both the body section **900** and a surrounding base portion **909** to facilitate the molding of this body section **900**. The body section **900** may be subsequently separated from its surrounding base portion by suitable trimming it therefrom.

FIG. **35** illustrates a transmission line **420** (after separation from a body portion **909**) of the invention that extends between two circuit boards **421**, **422**. The transmission line **420** mates with a connector **424**, similar to the type shown in FIG. **26** and extends outwardly therefrom to a surface mount connection arrangement **425** disposed on the circuit board **422** (or formed as surface mounting "feet" that are molded or otherwise formed with the transmission line that may be attached to opposing contact pads or traces on the surface of the circuit board **422**). Such a connection may include a plurality of contact members **426** that extend upwardly from the surface **427** and the contact members preferably includes conductive surfaces **428** that are arranged in opposition to the conductive strips **430** so that they will make direct contact with the strips **430** of the transmission element. They may be soldered, or otherwise attached or may rely solely upon frictional contact to make an electrical connection. The arrangement illustrated also includes an exterior protective jacket **431** formed of a plastic or metal (provided that the interior side thereof which opposes the transmission element is protected with an insulator) to protect the transmission channel from damage and exterior contact.

In FIG. **36**, the transmission link **420** is illustrated in a right-angle configuration extending between two circuit boards. The transmission link may be molded into such a shape with the desired physical dimensions of thickness, spacing, etc. so as to maintain the waveguide parameters through the turning radius. In the application shown, the transmission link interconnects a surface mount connector **424** with a circuit board **422** by way of a surface mount arrangement **425** directly positioned on the board surface **427**.

FIGS. **37** and **38** illustrate another embodiment of a grouped element channel transmission line, or link **650**, that is particularly suitable for carrying high voltages and currents at high-density contact spacings. The body of the transmission line **650** is formed from a dielectric and it has a series of grooves, or slots **651**, formed therein that extend into the body portion thereof from one surface **652** thereof. The sidewalls **654** of these slots are conductively coated with a conductive material, such as by plating, and in effect define a series of "plates" **655** that are opposed to each other and are separated by the intervening space, or air, that will typically occupy the slots **651**. In the left of FIGS. **37** and **38**, an insert molded plug **658** is shown and this plug includes a cap portion **659** and one or more tongues, or fillers **660** that depend from the cap portion **659** and which extend into and completely occupy the space of the slots **651**. The plug **658**, especially the fill portion **660** thereof extends between the opposing conductive surfaces and insulates them to prevent arcing from occurring between them. The plug is filled with a dielectric material that preferably has a high dielectric constant, one that is equal to or greater higher than the dielectric constant of the dielectric body. A ground plane **659**

may be deposited on the lower surface of the transmission line of FIGS. **37** & **38** to provide increased capacitive coupling.

In this manner, and as shown best schematically in FIG. **38**, the opposed polarity (i.e., "+" or "-") conductive pairs of contacts are electrically isolated from each other, but nevertheless define a complete circuit. The sizes involved with the transmission elements of the present invention permit very high densities to be achieved with a low inductance delivery mode, especially due to the large number of common parallel current paths. To the right of FIGS. **37** and **38** is shown another means for accomplishing this isolation, preferably with signal transmitting conductive surfaces, namely the use of a conformal coating **661** that conforms to the overall slot and land configuration but which provides electrical insulation or isolation between the two conductive surfaces. The spacing between the plated surfaces **654**, **655** may be very small, on the order of 0.4 mm and the like and the insulative coating or film **661** prevents arcing or shorting between pairs of conductive elements. The use of opposed pairs in the transmission lines, over which is traversed current across and possibly on two opposing surfaces thereof, will lead to a lower loop inductance of the transmission line system. The conformal coating or film **661** preferably has a dielectric constant that is lower than that of the dielectric body and a dielectric constant that is close to that of air, 1.0 is most preferred.

As shown in FIG. **39**, the transmission lines of the present invention may also be used to conduct power at very low impedance. In the transmission line **750** illustrated, a dielectric body portion **751** is provided with a series of grooves **752** formed in its outer surfaces **753**. In a departure from some of the previous embodiments, more than just the exterior surfaces of the land portions of the dielectric body are plated with a conductive material. Two such lands **755** are continuously plated for the length of the transmission line **750** and they are interconnected by plating in the groove, or trough **752**, that separates them, so that five distinct surfaces are plated, these include the two lands **755**, the two sidewalls **756** of the grooves **752** and the base **757** of the groove, which all cooperate to form a single power terminal of the transmission line. In this arrangement, there is an increased surface area which will provide an increased capacitance between the power terminal and an associated ground (or power return) terminal. The low inductance and increased capacitance will serve to lower the impedance of the overall system, so that the transmission lines of the present invention may be used for low impedance power delivery. Although shown as a hexagonal configuration, it will be understood that this arrangement would be useful in any similar configuration, such as one with raised, semi-circular lands which are interconnected by webs that form intervening valleys of different shape between adjacent lands **755**.

FIGS. **40** & **41** illustrate possible executions of the use of a mixed signal and power transmission line. In FIG. **40**, it can be seen that the transmission line **950** has two signal traces, or extents **951** and a single, wide power trace, or extent **952** formed on at least one, and preferably both (opposing) surfaces **955** of the transmission line. The power extents define a large power channel with an enlarged continuous conductor for increased current handling and high capacitance with the enlarged plate areas. The power and signal regions of this type of structure may be separated by a wide "isolation" region **956** that is molded or formed as part of the transmission line. In manufacturing processes such as extrusion, the tolerances and dimensions of the isolation region may be controlled with high reliability to obtain the maximum electrical benefit and minimize cross-contamination or shorting contact between the power and signal extents.

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FIG. 41 illustrates a similar structure except that the power region includes a plurality of power extents 952a that are separated by intervening isolation regions.

While the preferred embodiment of the invention have been shown and described, it will be apparent to those skilled in the art that changes and modifications may be made therein without departing from the spirit of the invention, the scope of which is defined by the appended claims.

What is claimed is:

1. A termination assembly for a differential signal, high-frequency transmission line, the transmission line having a dielectric body, the body having a plurality of raised lands interconnected by a web portion, each of the raised lands including a pair of conductive traces disposed on exterior surfaces thereof, the conductive traces being arranged in pairs on said raised lands and spaced apart from each a given distance along the length of said raised lands between two opposing ends thereof, the termination assembly comprising:

a housing, the housing including a dielectric body portion having a cavity disposed therein which is complementary in configuration to said transmission line body and which is sized to receive an end of said transmission line, the housing cavity including a plurality of wide portions interconnected by a slot, the wide portions receiving said transmission line dielectric body raised lands and the slot receiving said transmission line dielectric body web when an end of said transmission line dielectric body is inserted into said housing cavity, the housing further including a plurality of conductive elements spaced apart from each other and disposed within the cavity so as to electrically engage said transmission line conductive traces when said transmission line dielectric body end is inserted into said cavity, and said housing further including conductive tail portions projecting exterior of said cavity and said body portion for engagement with opposing conductive surfaces of a circuit board.

2. The termination assembly of claim 1, wherein said plurality of conductive traces are arranged in said housing cavity in pairs, the pairs being on opposite sides of said slot.

3. The termination assembly of claim 2, wherein each of said conductive elements includes a dual loop terminal that provides a redundant circuit path between an opposing conductive trace of said transmission line and a conductive surface of said circuit board.

4. The termination assembly of claim 2, wherein said conductive elements each have a tail portion that extends from said housing, the tail portions being turned inwardly toward said housing slot so that they do not project outwardly away from said housing slot past edges of connector housing.

5. The termination assembly of claim 2, wherein each of said conductive elements includes a terminal formed from a length of wire bent upon itself to form a U-shaped terminal.

6. The termination assembly of claim 5, wherein said terminals include open ends that define contact portions thereof and closed ends that define tail portions thereof.

7. The termination assembly of claim 2, further including a conductive capacitive coupling member that is disposed within said slot and which is interposed between said conductive elements, the coupling member providing a conductive surface spaced apart from said conductive elements which increases capacitive coupling between said conductive elements.

8. The termination assembly of claim 7, wherein said coupling member has an inverted U-shape with an elongated

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backbone portion and a plurality of legs that are spaced apart from each other by intervening spaces along the backbone portion, the legs depending downwardly from said backbone portion toward said circuit board.

9. The termination assembly of claim 7, further including a terminal carrier member held within said housing, said terminal carrier member supporting both said conductive elements and said coupling member.

10. The termination assembly of claim 9, wherein said coupling member legs have a width greater than corresponding widths of said conductive elements.

11. A termination assembly for a differential signal, high-frequency transmission line, the transmission line having a dielectric body with a pair of conductive traces disposed on the exterior of the body, the two conductive traces being spaced apart from each a given distance along the length of said body between the two ends thereof, the termination assembly comprising:

a housing, the housing including a dielectric body portion having a cavity disposed therein sized to receive an end of said transmission line, a pair of conductive elements spaced apart from each other and disposed within the cavity so as to electrically engage said transmission line conductive traces when said transmission line end is inserted into said cavity, and conductive tail portions projecting exterior of said cavity and said body portion for engagement with opposing conductive surfaces of a circuit board;

a conductive capacitive coupling member that is disposed within said slot and which is interposed between said conductive elements, the coupling member providing a conductive surface spaced apart from said conductive elements which increases capacitive coupling between said conductive elements; and,

a terminal carrier member held within said housing, said terminal carrier member supporting both said conductive elements and said coupling member.

12. The termination assembly of claim 11, wherein said coupling member has an inverted U-shape with an elongated backbone portion and a plurality of legs that are spaced apart from each other by intervening spaces along the backbone portion, the legs depending downwardly from said backbone portion toward said circuit board.

13. The termination assembly of claim 11, wherein said coupling member legs have a width greater than corresponding widths of said conductive elements.

14. The termination assembly of claim 11, wherein said conductive elements each have a tail portion that extends from said housing, the tail portions being turned inwardly toward said housing slot so that they do not project outwardly away from said housing slot past edges of connector housing.

15. The termination assembly of claim 11, wherein each of said conductive elements includes a dual loop terminal that provides a redundant circuit path between an opposing conductive trace of said transmission line and a conductive surface of said circuit board.

16. The termination assembly of claim 11, wherein each of said conductive elements includes a terminal formed from a length of wire bent upon itself to form a U-shaped terminal.

17. The termination assembly of claim 16, wherein said terminals include open ends that define contact portions thereof and closed ends that define tail portions thereof.